

## General Description

The XR77129 is a quad channel digital Pulse Width Modulated (PWM) step down (buck) controller. A wide 6V to 40V input voltage range allows for single supply operation from standard power rails.

With integrated FET gate drivers, two LDOs for standby power and a 105kHz to 1.23MHz independent channel to channel programmable constant operating frequency, the XR77129 reduces overall component count, solution footprint and optimizes conversion efficiencies. A selectable digital Pulse Frequency Mode (PFM) capable of better than 80% efficiency at light current load and low operating current allow for portable and Energy Star compliant applications. Each XR77129 channel's output voltage is individually programmable down to 0.6V with a resolution of 2.5mV, and is configurable for precise soft start and soft stop sequencing, including delay and ramp control.

The XR77129 operations are fully controlled via a SMBus-compliant I<sup>2</sup>C interface allowing for advanced local and/or remote reconfiguration, full performance monitoring and reporting as well as fault handling.

Built-in independent output Over-Voltage, Over-Temperature, Over-Current and Under-Voltage Lockout protections insure safe operation under abnormal operating conditions.

The XR77129 is offered in a RoHS compliant, "green"/halogen free 44-pin TQFN package.

## FEATURES

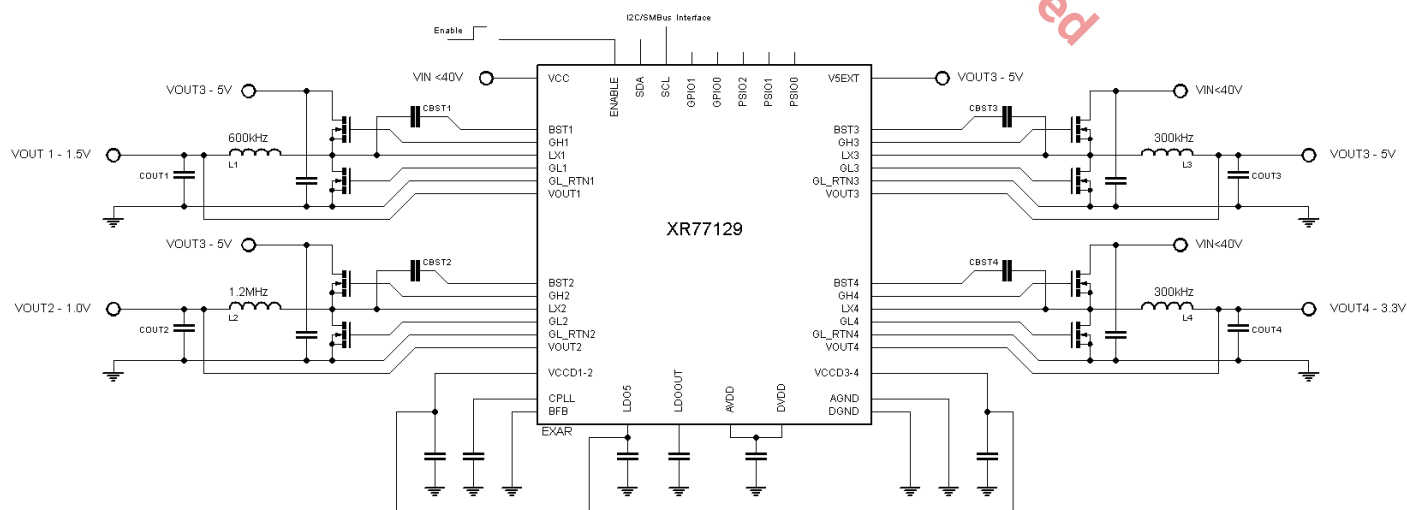
- Quad Channel Step-down Controller
  - Digital PWM 105kHz-1.23MHz Operation
  - Individual Channel Frequency Selection
  - Patented digital PFM with Ultrasonic mode
  - Patented Over Sampling Feedback
  - Programmable 5 coefficient PID control
  - Integrated MOSFET Drivers
- 6V to 40V Input Voltage
- 0.6V to 5.5V Output Voltage (higher with external feedback resistors)
- SMBus Compliant I<sup>2</sup>C Interface
- Full Power Monitoring and Reporting
- 3 x 15V Capable PSIO + 2 x GPIOs
- Full Start/Stop Sequencing Support
- Built-in Thermal, Over-Current, UVLO and Output Over-Voltage Protections
- On Board 5V and LDOOUT Standby LDOs
- On Board Non-Volatile Memory
- Supported by PowerArchitect™ (PA5)

## APPLICATIONS

- Industrial Control Systems
- Automatic Test Equipment
- Video Surveillance Systems
- Automotive Infotainment

Ordering Information – [back page](#)

## Typical Application



## Absolute Maximum Ratings

Stresses beyond the limits listed below may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

|                                           |                    |
|-------------------------------------------|--------------------|
| VCCD, LDO5, LDOOUT, GLx, VOUTx.....       | -0.3V to 7.0V      |
| ENABLE, V5EXT.....                        | -0.3V to 7.0V      |
| GPIO0/1, SCL, SDA.....                    | 6.0V               |
| PSIO Inputs, BFB.....                     | 18V                |
| DVDD, AVDD.....                           | 2.0V               |
| VCC.....                                  | 43V                |
| LX#.....                                  | -1V to 43V         |
| BSTx, GHx.....                            | VLx + 6V           |
| Storage Temperature.....                  | -65°C to +150°C    |
| Power Dissipation.....                    | Internally Limited |
| Lead Temperature (Soldering, 10 sec)..... | 300°C              |
| ESD Rating (HBM - Human Body Model).....  | 2kV                |

## Operating Conditions

|                                              |                 |
|----------------------------------------------|-----------------|
| Input Voltage Range VCC.....                 | 6V to 40V       |
| VOUT1, 2, 3, 4.....                          | 5.5V            |
| Junction Temperature Range.....              | -40°C to +125°C |
| JEDEC Thermal Resistance $\theta_{JA}$ ..... | 32°C/W          |

## Electrical Characteristics

Unless otherwise noted:  $T_J = 25^\circ\text{C}$ , VCC=6V to 40V, V5EXT open. Limits applying over the full operating temperature range are denoted by a “•”

| Symbol              | Parameter          | Conditions                                                                                                                                      | Min | Typ | Max | Units |
|---------------------|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|-------|
| Quiescent Current   |                    |                                                                                                                                                 |     |     |     |       |
| I <sub>SUPPLY</sub> | VCC Supply Current | SHUTDOWN<br>EN = 0V, VCC = 24V                                                                                                                  |     | 20  | 30  | μA    |
|                     |                    | STANDBY<br>I/Os programmed as inputs, VCC = 12V,<br>EN = 5V                                                                                     |     | 550 | 650 | μA    |
|                     |                    | 2ch PFM<br>2 channels on set at 5V, VOUT forced to<br>5.1V, no load, non-switching, ultra-sonic<br>off, VCC = 12V, no I <sup>2</sup> C activity |     | 3.1 |     | mA    |
|                     |                    | 4ch PFM<br>4 channels on set at 5V, VOUT forced to<br>5.1V, no load, non-switching, ultra-sonic<br>off, VCC = 12V, no I <sup>2</sup> C activity |     | 4.0 |     | mA    |
|                     |                    | 4ch PWM<br>All channels enabled, f <sub>SW</sub> = 600kHz, gate<br>drivers unloaded, no I <sup>2</sup> C activity                               |     | 18  |     | mA    |

| Symbol                                                            | Parameter                                           | Conditions                                            |   | Min   | Typ  | Max   | Units |
|-------------------------------------------------------------------|-----------------------------------------------------|-------------------------------------------------------|---|-------|------|-------|-------|
| V <sub>ENABLE</sub>                                               | ENABLE Turn On Threshold                            | VCC = 12V, Enable Rising                              |   | 0.65  |      | 0.95  | V     |
| I <sub>LEAK</sub>                                                 | ENABLE Pin Leakage Current                          | EN = 5V                                               |   |       | 3.6  | 10    | μA    |
|                                                                   |                                                     | EN = 0V                                               |   | -10   |      |       | μA    |
| Input Voltage Range and Undervoltage Lockout                      |                                                     |                                                       |   |       |      |       |       |
| VCC                                                               | VCC Range                                           |                                                       | • | 6     |      | 40    | V     |
| Voltage Feedback Accuracy and Output Voltage Set Point Resolution |                                                     |                                                       |   |       |      |       |       |
| V <sub>A_VO</sub>                                                 | VOUT Regulation Accuracy                            | Low Output Range<br>0.6 ≤ VOUT ≤ 1.6V, PWM operation  |   | -5    |      | 5     | mV    |
|                                                                   |                                                     |                                                       | • | -12.5 |      | 12.5  | mV    |
|                                                                   |                                                     | Mid Output Range<br>0.6 ≤ VOUT ≤ 3.2V, PWM operation  |   | -10   |      | 10    | mV    |
|                                                                   |                                                     |                                                       | • | -25   |      | 25    | mV    |
|                                                                   |                                                     | High Output Range<br>0.6 ≤ VOUT ≤ 5.5V, PWM operation |   | -20   |      | 20    | mV    |
|                                                                   |                                                     |                                                       | • | -50   |      | 50    | mV    |
| V <sub>R_VO</sub>                                                 | VOUT Regulation Range                               | Without external divider network                      | • | 0.6   |      | 5.5   | V     |
| V <sub>NATIVE</sub>                                               | VOUT Native Set Point Resolution                    | Low Range                                             |   |       | 12.5 |       | mV    |
|                                                                   |                                                     | Mid Range                                             |   |       | 25   |       | mV    |
|                                                                   |                                                     | High Range                                            |   |       | 50   |       | mV    |
| V <sub>FINE</sub>                                                 | VOUT Fine Set Point Resolution <sup>1</sup>         | Low Range                                             |   |       | 2.5  |       | mV    |
|                                                                   |                                                     | Mid Range                                             |   |       | 5    |       | mV    |
|                                                                   |                                                     | High Range                                            |   |       | 10   |       | mV    |
| R <sub>IN</sub>                                                   | VOUT Input Resistance                               | Low Range                                             |   |       | 120  |       | kΩ    |
|                                                                   |                                                     | Mid Range                                             |   |       | 80   |       | kΩ    |
|                                                                   |                                                     | High Range                                            |   |       | 65   |       | kΩ    |
| R <sub>IN</sub>                                                   | VOUT Input Resistance in PFM                        | Low Range                                             |   |       | 10   |       | MΩ    |
|                                                                   |                                                     | Mid Range                                             |   |       | 1    |       | MΩ    |
|                                                                   |                                                     | High Range                                            |   |       | 0.67 |       | MΩ    |
| V <sub>SET_PG</sub>                                               | Power Good and OVP Set Point Range (from set point) | Low Range                                             |   | -155  |      | 157.5 | mV    |
|                                                                   |                                                     | Mid Range                                             |   | -310  |      | 315   | mV    |
|                                                                   |                                                     | High Range                                            |   | -620  |      | 630   | mV    |
| V <sub>SET_PG</sub>                                               | Power Good and OVP Set Point Accuracy               | Low Range                                             |   | -5    |      | 5     | mV    |
|                                                                   |                                                     | Mid Range                                             |   | -10   |      | 10    | mV    |
|                                                                   |                                                     | High Range                                            |   | -20   |      | 20    | mV    |
| V <sub>SET_BF</sub>                                               | BFB Set Point Range                                 |                                                       |   | 9     |      | 16    | V     |
| V <sub>RES_BF</sub>                                               | BFB Set Point Resolution                            |                                                       |   |       | 1    |       | V     |
| V <sub>A_BF</sub>                                                 | BFB Accuracy                                        |                                                       |   | -0.5  |      | 0.5   | V     |

| Symbol                                | Parameter                                                           | Conditions                                                                                 |   | Min   | Typ        | Max  | Units    |
|---------------------------------------|---------------------------------------------------------------------|--------------------------------------------------------------------------------------------|---|-------|------------|------|----------|
| Current and AUX ADC (Monitoring ADCs) |                                                                     |                                                                                            |   |       |            |      |          |
| V <sub>A_CS</sub>                     | Current Sense Accuracy                                              | Low Range ( $\leq 120\text{mV}$ ), -60mV applied                                           |   | -2.5  | $\pm 1.25$ | 2.5  | mV       |
|                                       |                                                                     |                                                                                            | • | -6.25 |            | 6.25 | mV       |
|                                       |                                                                     | High Range ( $\leq 280\text{mV}$ ), 150mV applied                                          |   | -5    | $\pm 2.5$  | 5    | mV       |
|                                       |                                                                     |                                                                                            | • | -12.5 |            | 12.5 | mV       |
| INL <sub>CS</sub>                     | Current Sense ADC INL                                               |                                                                                            |   |       | $\pm 0.4$  |      | LSB      |
| DNL <sub>CS</sub>                     | Current Sense DNL                                                   |                                                                                            |   |       | $\pm 0.4$  |      | LSB      |
| V <sub>SET_CS</sub>                   | Current Limit Set Point Resolution and Current Sense ADC Resolution | Low Range ( $\leq 120\text{mV}$ )                                                          |   |       | 1.25       |      | mV       |
|                                       |                                                                     | High Range ( $\leq 280\text{mV}$ )                                                         |   |       | 2.5        |      | mV       |
| V <sub>CS</sub>                       | Current Sense ADC Range                                             | Low Range ( $\leq 120\text{mV}$ )                                                          |   | -120  |            | 20   | mV       |
|                                       |                                                                     | High Range ( $\leq 280\text{mV}$ )                                                         |   | -280  |            | 40   | mV       |
| V <sub>ADC_VO</sub>                   | VOUT ADC Resolution                                                 | Low Range                                                                                  |   |       | 15         |      | mV       |
|                                       |                                                                     | Mid Range                                                                                  |   |       | 30         |      | mV       |
|                                       |                                                                     | High Range                                                                                 |   |       | 60         |      | mV       |
| LSB <sub>ADC</sub>                    | VOUT ADC Accuracy                                                   |                                                                                            |   | -1    |            | 1    | LSB      |
| V <sub>ADC</sub>                      | VCC ADC Range                                                       |                                                                                            |   | 5.0   |            | 51.2 | V        |
| V <sub>R_ADC</sub>                    | VCC ADC Resolution                                                  |                                                                                            |   |       | 400        |      | mV       |
| V <sub>A_ADC</sub>                    | VCC ADC Accuracy                                                    | VCC $\leq 20\text{V}$                                                                      |   | -1    |            | 1    | LSB      |
| T <sub>R_ADC</sub>                    | Die Temp ADC Resolution                                             |                                                                                            |   |       | 5          |      | °C       |
| T <sub>ADC</sub>                      | Die Temp ADC Range                                                  | Output value is in Kelvin                                                                  |   | -44   |            | 156  | °C       |
| Linear Regulators                     |                                                                     |                                                                                            |   |       |            |      |          |
| V <sub>O_LDO5</sub>                   | LDO5 Output Voltage                                                 | 5.5V $\leq$ VCC $\leq$ 25V<br>0mA $<$ I <sub>LDO5OUT</sub> $<$ 130mA, LDOOUT off           | • | 4.85  | 5.0        | 5.15 | V        |
| I <sub>CL_LDO5</sub>                  | LDO5 Current Limit                                                  | LDO5 Fault Set                                                                             | • | 135   | 155        | 180  | mA       |
|                                       | LDO5 UVLO                                                           | VCC Rising                                                                                 | • | 4.6   |            |      | V        |
|                                       | LDO5 PGOOD Hysteresis                                               | VCC Falling                                                                                |   |       | 375        |      | mV       |
|                                       | LDO5 Bypass Switch Resistance                                       |                                                                                            |   |       | 1.1        | 1.5  | $\Omega$ |
|                                       | Bypass Switch Activation Threshold                                  | V5EXT Rising, % of threshold setting                                                       | • | 2.5   |            | 2.5  | %        |
|                                       | Bypass Switch Activation Hysteresis                                 | V5EXT Falling                                                                              |   |       | 150        |      | mV       |
|                                       | LDOOUT Output Voltage                                               | 4.6V $\leq$ LDO5 $\leq$ 5.5V<br>0mA $<$ I <sub>LDOOUT</sub> $<$ 50mA<br>LDOOUT set to 3.3V | • | 3.15  | 3.3        | 3.45 | V        |
|                                       | LDOOUT Current Limit                                                | LDOOUT Fault Set, LDOOUT set to 3.3V                                                       | • | 50    |            | 85   | mA       |
|                                       | Maximum total LDO5 loading during ENABLE start-up                   | ENABLE transition from logic low to high. Once LDO5 in regulation, above limits apply.     |   |       |            | 75   | mA       |

| Symbol                                  | Parameter                                          | Conditions                                                 |  | Min                  | Typ  | Max                | Units |
|-----------------------------------------|----------------------------------------------------|------------------------------------------------------------|--|----------------------|------|--------------------|-------|
| PWM Generators and Oscillator           |                                                    |                                                            |  |                      |      |                    |       |
| f <sub>SW</sub>                         | Switching Frequency Range                          | Steps defined in table                                     |  | 105                  |      | 1230               | kHz   |
|                                         | Switching Frequency Accuracy                       |                                                            |  | -5                   |      | 5                  | %     |
| f <sub>CLKIN</sub>                      | CLOCK IN Synchronization Frequency                 | When synchronizing to an external clock (Range 1)          |  | 20                   | 25.7 | 31                 | MHz   |
|                                         |                                                    | When synchronizing to an external clock (Range 2)          |  | 10                   | 12.8 | 15.5               | MHz   |
| I <sup>2</sup> C and GPIOs <sup>2</sup> |                                                    |                                                            |  |                      |      |                    |       |
| V <sub>IL</sub>                         | Input Pin Low Level                                |                                                            |  |                      |      | 0.8                | V     |
| V <sub>IH</sub>                         | Input Pin High Level                               |                                                            |  | 1.35                 |      |                    | V     |
|                                         | Input Pin Leakage Current                          |                                                            |  |                      |      | 1                  | μA    |
| V <sub>OL</sub>                         | Output Pin Low Level                               | I <sub>SINK</sub> = 1mA                                    |  |                      |      | 0.4                | V     |
| V <sub>OH</sub>                         | Output Pin High Level                              | I <sub>SOURCE</sub> = 1mA                                  |  | 2.4                  |      |                    | V     |
|                                         |                                                    | I <sub>SOURCE</sub> = 0mA                                  |  |                      | 3.3  | 3.6                | V     |
|                                         | Output Pin High-Z Leakage Current (GPIO pins only) |                                                            |  |                      |      | 10                 | μA    |
|                                         | Maximum Sink Current                               | Open Drain Mode                                            |  |                      |      | 1                  | mA    |
|                                         | I/O Frequency                                      |                                                            |  |                      |      | 30                 | MHz   |
| PSIOs <sup>3</sup>                      |                                                    |                                                            |  |                      |      |                    |       |
| V <sub>IL</sub>                         | Input Pin Low Level                                |                                                            |  |                      |      | 0.8                | V     |
| V <sub>IH</sub>                         | Input Pin High Level                               | PSIO0 and PSIO1                                            |  | 2                    |      |                    | V     |
| V <sub>IH</sub>                         | Input Pin High Level                               | PSIO2                                                      |  | 1.35                 |      |                    | V     |
|                                         | Input Pin Leakage Current                          |                                                            |  |                      |      | 1                  | μA    |
| V <sub>OL</sub>                         | Output Pin Low Level                               | I <sub>SINK</sub> = 3mA                                    |  |                      |      | 0.4                | V     |
| V <sub>OH</sub>                         | Output Pin High Level                              | Open Drain. External pull-up resistor to user supply.      |  |                      |      | 15                 | V     |
|                                         | Output Pin High-Z Leakage Current (PSIO pins only) |                                                            |  |                      |      | 10                 | μA    |
|                                         | I/O Frequency                                      |                                                            |  |                      |      | 5                  | MHz   |
| SMBus (I <sup>2</sup> C) Interface      |                                                    |                                                            |  |                      |      |                    |       |
| V <sub>IL</sub>                         | Input Pin Low Level                                | V <sub>IO</sub> = 3.3V ±10%                                |  |                      |      | 0.3V <sub>IO</sub> | V     |
| V <sub>IH</sub>                         | Input Pin High Level                               | V <sub>IO</sub> = 3.3V ±10%                                |  | 0.7V <sub>IO</sub>   |      |                    | V     |
| V <sub>HYS</sub>                        | Hysteresis of Schmitt Trigger Inputs               | V <sub>IO</sub> = 3.3V ±10%                                |  | 0.05 V <sub>IO</sub> |      |                    | V     |
| V <sub>OL</sub>                         | Output Pin Low Level (open drain or collector)     | I <sub>SINK</sub> = 3mA                                    |  |                      |      | 0.4                | V     |
| I <sub>LEAK</sub>                       | Input Leakage Current                              | Input is between 0.1V <sub>IO</sub> and 0.9V <sub>IO</sub> |  | -10                  |      | 10                 | μA    |

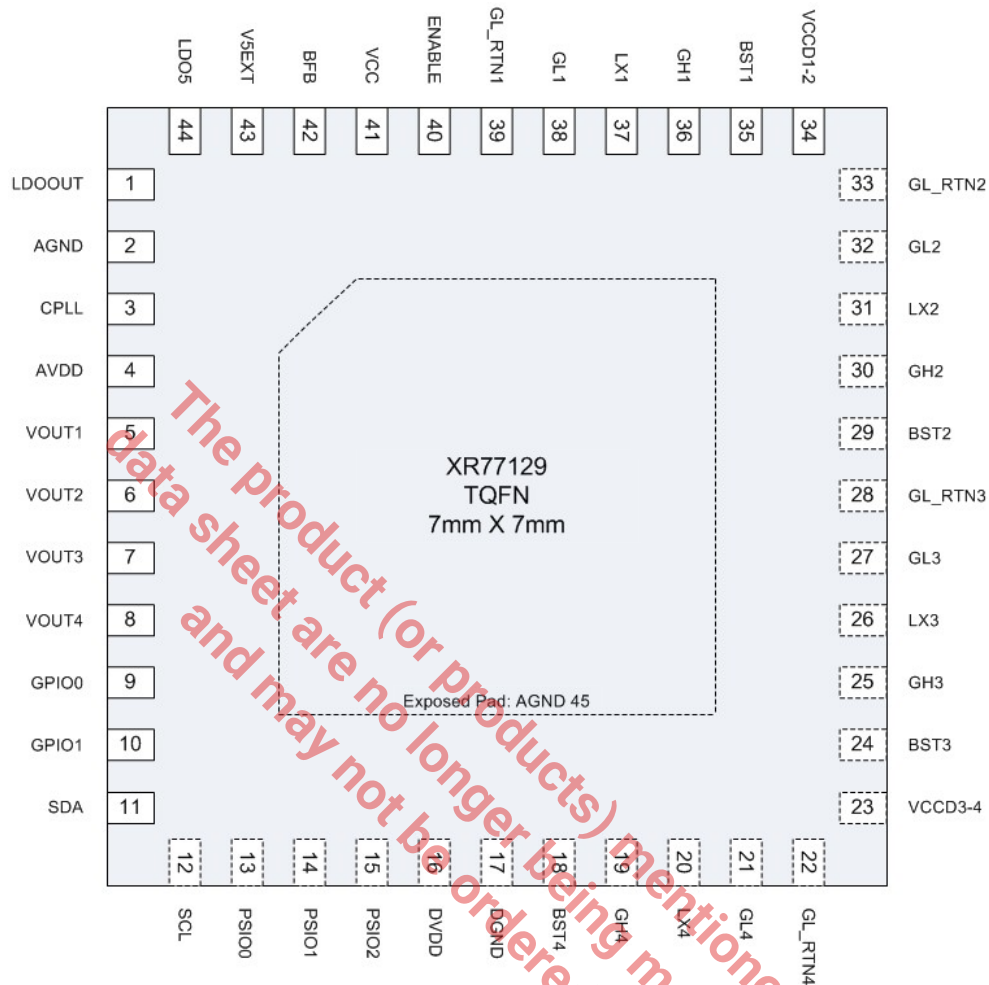
| Symbol       | Parameter                                        | Conditions                                                                                 | Min           | Typ      | Max | Units      |
|--------------|--------------------------------------------------|--------------------------------------------------------------------------------------------|---------------|----------|-----|------------|
|              | Output Fall Time from $V_{IHmin}$ to $V_{ILmax}$ | With a bus capacitance ( $C_b$ ) from 10pF to 400pF                                        | 20 + $0.1C_b$ |          | 250 | ns         |
|              | Internal Pin Capacitance                         |                                                                                            |               |          | 1   | pF         |
| Gate Drivers |                                                  |                                                                                            |               |          |     |            |
|              | GH, GL Rise Time                                 | At 10-90% of full scale, 1nF Cload                                                         |               | 17       |     | ns         |
|              | GH, GL Fall Time                                 | At 10-90% of full scale, 1nF Cload                                                         |               | 11       |     | ns         |
|              | GH, GL Pull-Up On-State Output Resistance        |                                                                                            |               | 4.35     | 5   | $\Omega$   |
|              | GH, GL Pull-Down On-State Output Resistance      |                                                                                            |               | 1.96     | 2.5 | $\Omega$   |
|              | GH, GL Pull-Down Off-Mode Resistance             | $V_{CC} = V_{CCD} = 0V$                                                                    |               | 48       |     | k $\Omega$ |
|              | Bootstrap Diode Forward Resistance               | at 10mA                                                                                    |               | 8.5      |     | $\Omega$   |
|              | Minimum On-Time                                  | 1nF of gate capacitance                                                                    |               | 50       |     | ns         |
|              | Minimum Off-Time                                 | 1nF of gate capacitance                                                                    |               | 125      |     | ns         |
|              | Minimum Programmable Dead Time                   | Does not include dead time variation from driver output stage, $T_{SW}$ = switching period |               | 20       |     | ns         |
|              | Maximum Programmable Dead Time                   |                                                                                            |               | $T_{SW}$ |     |            |
|              | Programmable Dead Time Adjustment Step           | 103MHz internal clock frequency                                                            |               | 607      |     | ps         |

Note 1: Fine Set Point Resolution not available in PFM

Note 2: 3.3V CMOS logic compatible, 5V tolerant

Note 3: 3.3V/5.0V CMOS logic compatible, maximum rating of 15.0V

## Pin Configuration



## Pin Assignments

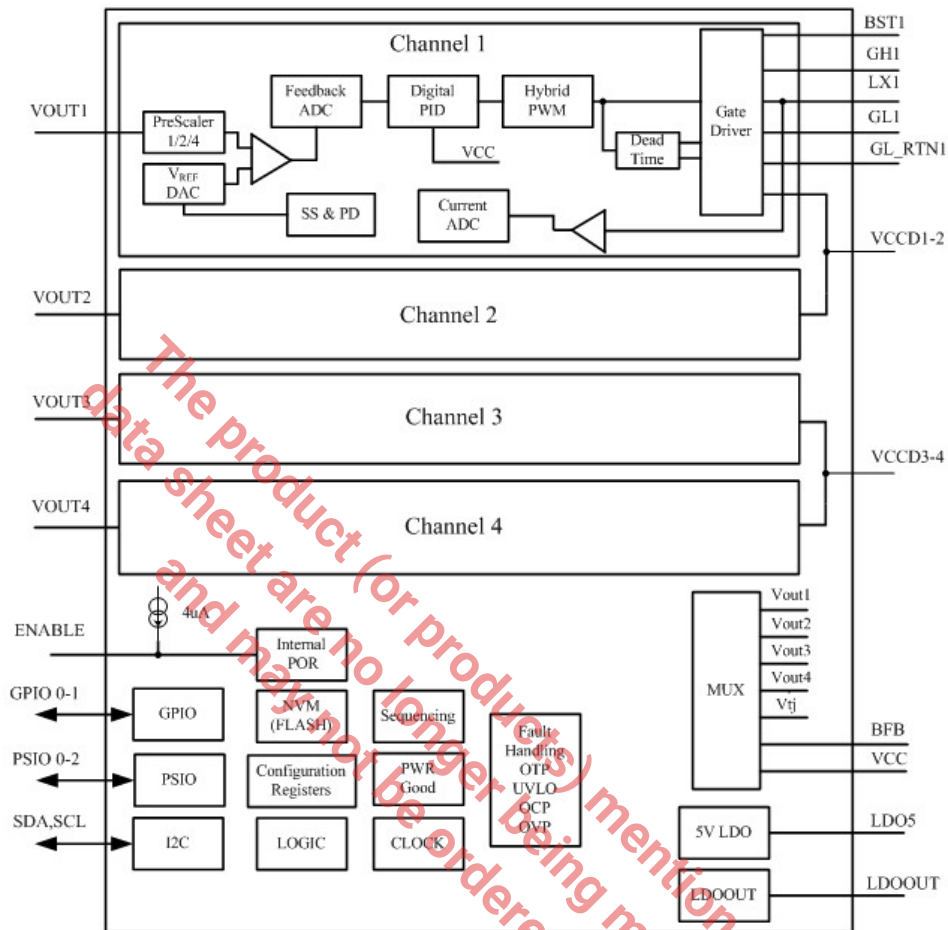
| Pin No.    | Pin Name                   | Description                                                                                                                                                        |
|------------|----------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1          | LDOOUT                     | Output of the standby LDO. This is a micro power LDO that needs to be configured or commanded to turn on.                                                          |
| 2          | AGND                       | Analog ground pin. This is the small signal ground connection.                                                                                                     |
| 3          | CPLL                       | Connect to a 2.2nF capacitor to GND.                                                                                                                               |
| 4          | AVDD                       | Output of the internal 1.8V LDO. A decoupling capacitor should be placed between AVDD and AGND close to the chip.                                                  |
| 5, 6, 7, 8 | VOUT1, VOUT2, VOUT3, VOUT4 | Connect to the output of the corresponding power stage. The output is sampled at least once every switching cycle.                                                 |
| 9, 10      | GPIO0, GPIO1               | These pins can be configured as inputs or outputs to implement custom flags, power good signals, enable/disable controls and synchronization to an external clock. |
| 11, 12     | SDA, SCL                   | SMBus/I <sup>2</sup> C serial interface communication pins.                                                                                                        |

| Pin No.        | Pin Name                       | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------------|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 13, 14, 15     | PSIO0, PSIO1, PSIO2            | Open drain, these pins can be used to control external power MOSFETs to switch loads on and off, shedding the load for fine grained power management. They can also be configured as standard logic outputs or inputs just as any of the GPIOs can be configured, but as open drains require an external pull-up when configured as outputs.                                                                                                                                                                                                                                                                                |
| 16             | DVDD                           | 1.8V supply input for digital circuitry. Connect pin to AVDD. Place a decoupling capacitor close to the controller IC.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 17             | DGND                           | Digital ground pin. This is the logic ground connection, and should be connected to the ground plane close to the PAD.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 18, 24, 29, 35 | BST4, BST3, BST2, BST1         | High side driver supply pin(s). Connect BST to the external capacitor as shown in the Typical Application Circuit. The high side driver is connected between the BST pin and LX pin and delivers the BST pin voltage to the high side FET gate each cycle.                                                                                                                                                                                                                                                                                                                                                                  |
| 19, 25, 30, 36 | GH4, GH3, GH2, GH1             | Output pin of the high side gate driver. Connect directly to the gate of an external N-channel MOSFET.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 20, 26, 31, 37 | LX4, LX3, LX2, LX1             | Lower supply rail for the GH high-side gate driver. Connect this pin to the switching node at the junction between the two external power MOSFETs and the inductor. These pins are also used to measure voltage drop across bottom MOSFETs in order to provide output current information to the control engine.                                                                                                                                                                                                                                                                                                            |
| 21, 27, 32, 38 | GL4, GL3, GL2, GL1             | Output pin of the low side gate driver. Connect directly to the gate of an external N-channel MOSFET.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 22, 28, 33, 39 | GL_RT4, GL_RT3, GL_RT2, GL_RT1 | Ground connection for the low side gate driver. This should be routed as a signal trace with GL. Connect to the source of the low side MOSFET.                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 23, 34         | VCCD3-4, VCCD1-2               | Gate Drive supply. Two independent gate drive supply pins where pin 34 supplies drivers 1 and 2 and pin 23 supplies drivers 3 and 4. One of the two pins must be connected to the LDO5 pin to enable two power rails initially. It is recommended that the other VCCD pin be connected to the output of a 5V switching rail (for improved efficiency or for driving larger external FETs), if available, otherwise this pin may also be connected to the LDO5 pin. A bypass capacitor (>1uF) to the system ground is recommended for each VCCD pin with the pin(s) connected to LDO5 with shortest possible length of etch. |
| 40             | ENABLE                         | If ENABLE is pulled high or allowed to float high, the chip is powered up (logic is reset, registers configuration loaded, etc.). The pin must be held low for the XR77129 to be placed into shutdown.                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 41             | VCC                            | Input voltage. Place a decoupling capacitor close to the controller IC. This input is used in UVLO fault generation.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 42             | BFB                            | Input from the 15V output created by the external boost supply. When this pin goes below a pre-defined threshold, a pulse is created on the low side drive to charge this output back to the original level. If not used, this pin should be connected to GND.                                                                                                                                                                                                                                                                                                                                                              |
| 43             | V5EXT                          | External 5V that can be provided. If one of the output channels is configured for 5V, then this voltage can be fed back to this pin for reduced operating current of the chip and improved efficiency.                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 44             | LDO5                           | Output of a 5V LDO. This LDO is used to power the internal Analog Blocks.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 45             | PAD                            | This is the die attach paddle, which is exposed on the bottom of the part. Connect externally to the ground plane.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |

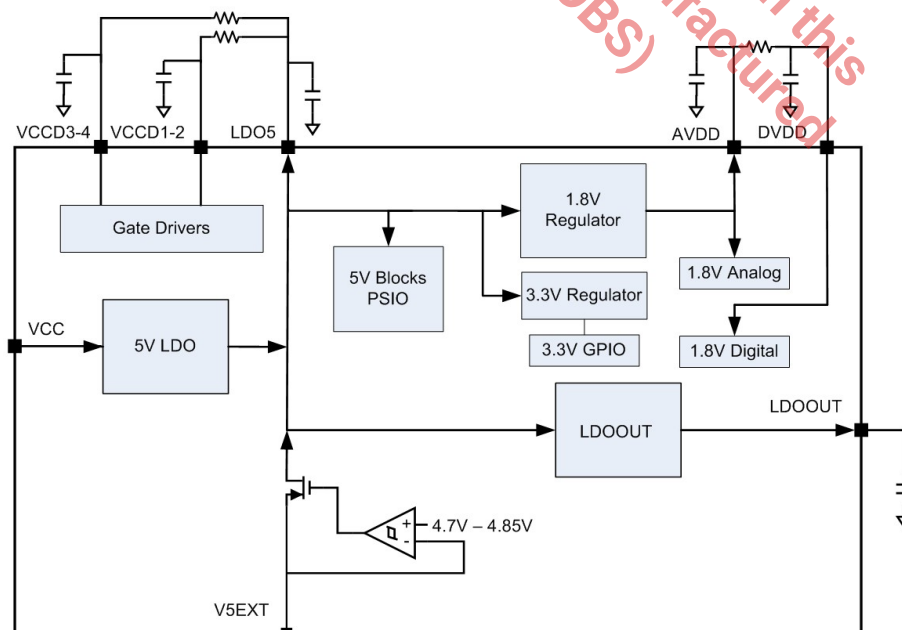


## Functional Block Diagram

XR77129 Block Diagram



LDO Block Diagram



## Typical Performance Characteristics

Unless otherwise noted: VCC = 12V, T<sub>A</sub> = 25°C

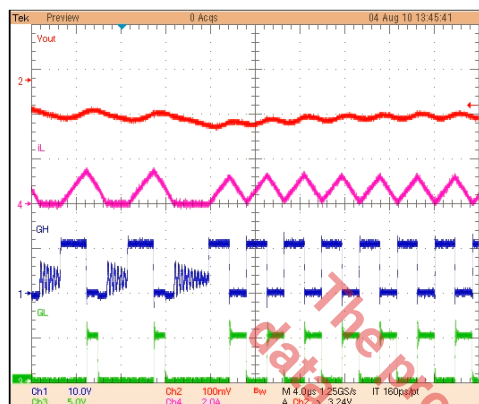


Figure 1: PFM to PWM Transition

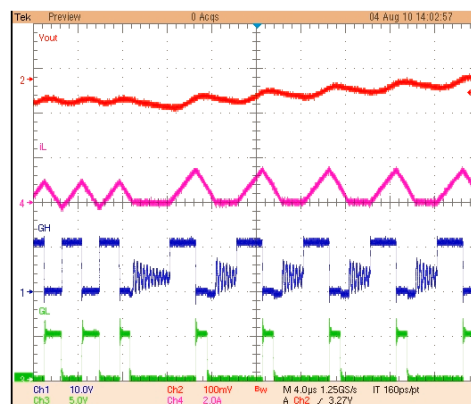


Figure 2: PWM to PFM Transition

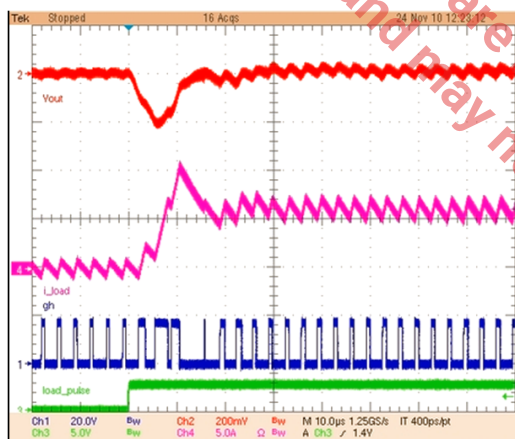


Figure 3: 0-6A Transient 300kHz PWM only

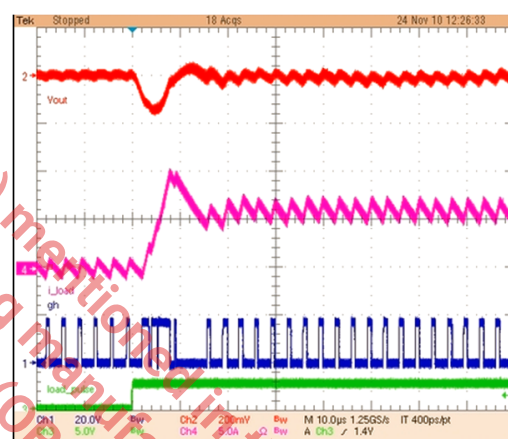


Figure 4: 0-6A Transient 300kHz with OVS +/-5%

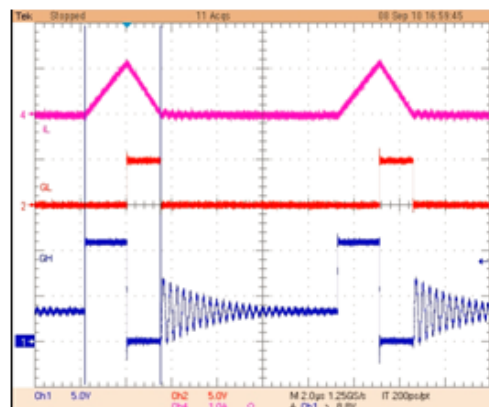


Figure 5: PFM Zero Current Accuracy

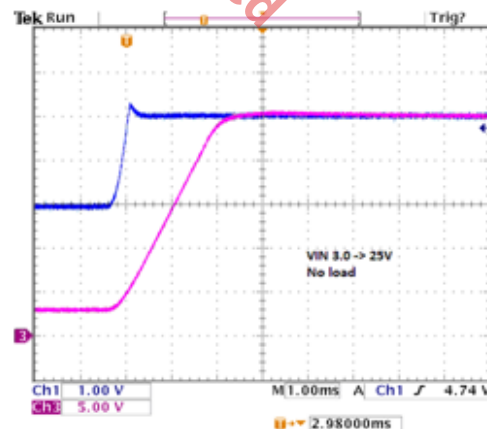


Figure 6: LDO5 Brown Out Recovery, No Load

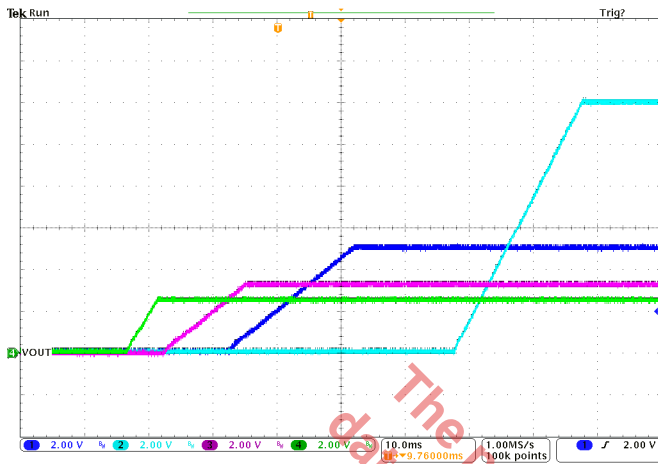


Figure 7: Sequential, Conditional Start-Up

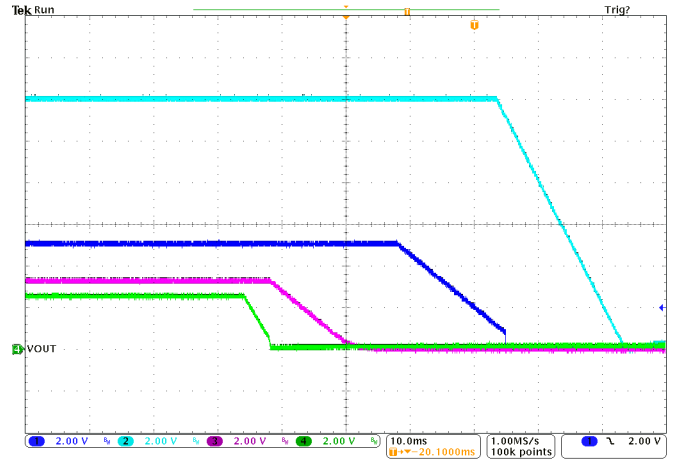


Figure 8: Sequential, Conditional Shut-Down

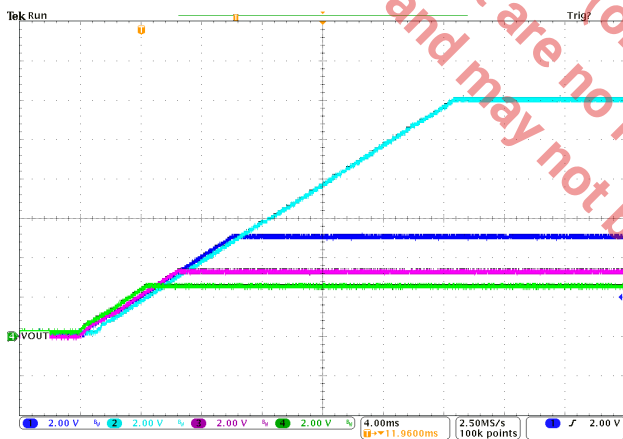


Figure 9: Simultaneous Start-Up

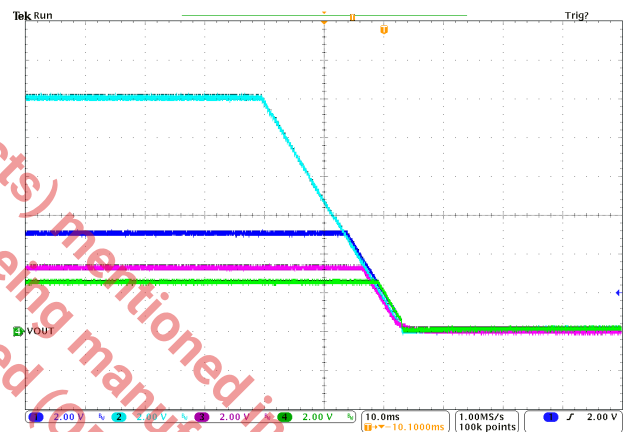


Figure 10: Simultaneous Shut-Down

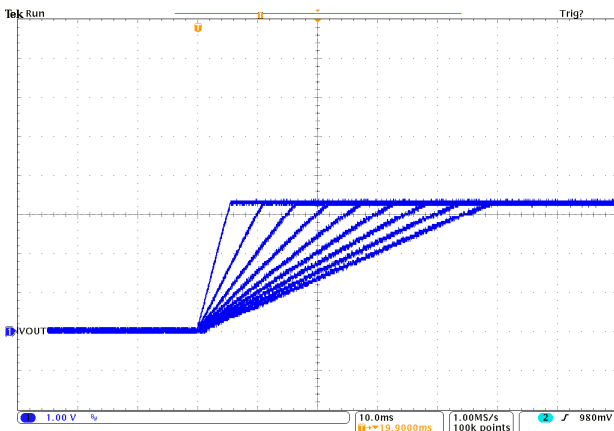


Figure 11: Ramp-Up Rate Dynamic Sweep

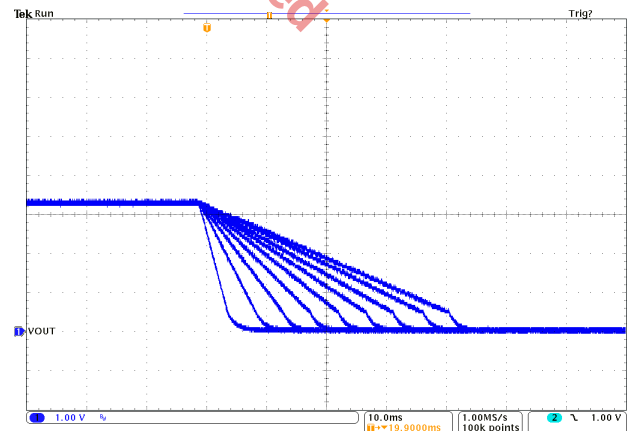


Figure 12: Ramp-Down Rate Dynamic Sweep

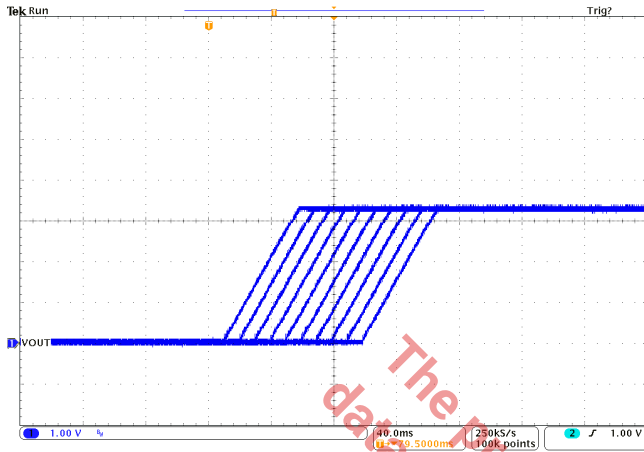


Figure 13: Start-Up Delay Dynamic Sweep

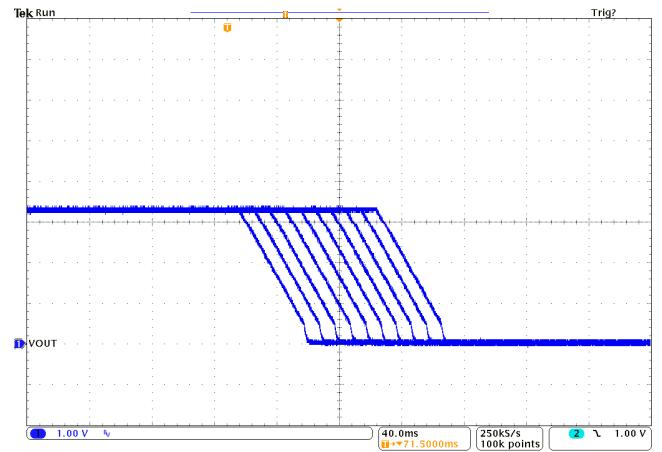


Figure 14: Shut-Down Delay Dynamic Sweep

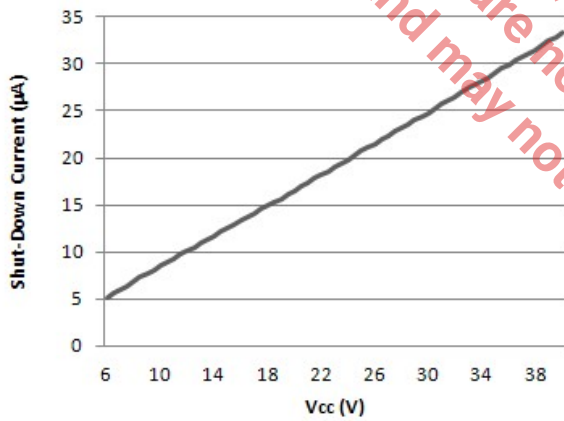


Figure 15: Shut-Down Current Versus VCC

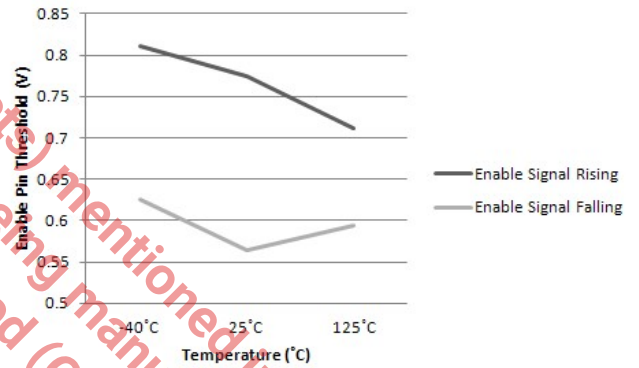


Figure 16: Enable Threshold Over Temperature at VCC=12V

## Functional Description

### Overview

The XR77129 is a quad-output digital pulse width modulation (PWM) controller with integrated gate drivers for use with synchronous buck switching regulators. Each output voltage can be programmed from 0.6V to 5.5V without the need for an external voltage divider. The wide range of programmable PWM switching frequency (from 105kHz to 1.2MHz) enables the user to optimize for efficiency or component sizes. Since the digital regulation loop requires no external passive components, loop performance is not compromised due to external component variation or operating condition.

The XR77129 provides a number of critical safety features such as Over-Current Protection (OCP), Over-Voltage Protection (OVP), Over-Temperature Protection (OTP), plus input Under-Voltage Lockout (UVLO). In addition, it has a number of key health monitoring features such as warning level flags for the safety functions, Power Good (PGOOD), etc., plus full monitoring of system voltages and currents. The above are all programmable and/or readable from the SMBus and many are steerable to the I/Os for hardware monitoring.

For hardware communication, the XR77129 has two logic level General Purpose Input-Output (GPIO) pins and three 15V, open drain, Power System Input-Output (PSIO) pins. Two pins are dedicated to the SMBus data (SDA) and clock (SCL). Additional pins include Chip Enable (Enable), Aux Boost Feedback (BFB) and External PLL Capacitor (CPLL).

In addition to providing four switching outputs, the XR77129 also provides control for an Aux boost supply, and two stand-by linear regulators for a total of seven customer usable supplies in a single device.

The 5V LDO is used for internal power and is also available for customer use to power external circuitry. LDOOUT is solely for customer use and is not used by the chip. There is also a 1.8V linear regulator which is for internal use only and should not be used externally.

A key feature of the XR77129 is its advanced power management capabilities. All four outputs are independently programmable and provide the user full control of the delay, ramp, and sequence during power up and power down. The user may also control how the outputs interact and power down in the event of a fault. This includes active ramp down of the output voltages to remove an output voltage as quickly as possible. Another useful feature is that the outputs can be defined and controlled as groups.

The XR77129 has two main types of programmable memory. The first type is runtime registers that contain

configuration, control and monitoring information for the chip. The second type is rewritable Non-Volatile Flash Memory that is used for permanent storage of the configuration data along with various chip internal functions. During power up, the run time registers are loaded from the flash memory allowing for standalone operation.

The XR77129 brings an extremely high level of functionality and performance to a programmable power system. Ever decreasing product budgets require the designer to quickly make good cost/performance trade-offs to be truly successful. By incorporating 4 switching channels, two user LDOs, a charge pump boost controller, along with internal gate drivers, all in a single package, the XR77129 allows for extremely cost effective power system designs. Another key cost factor that is often overlooked is the unanticipated Engineering Change Order (ECO). The programmable versatility of the XR77129, along with the lack of hard wired configuration components, allows for minor and major changes to be made in circuit by simple reprogramming.

## Regulation Loops

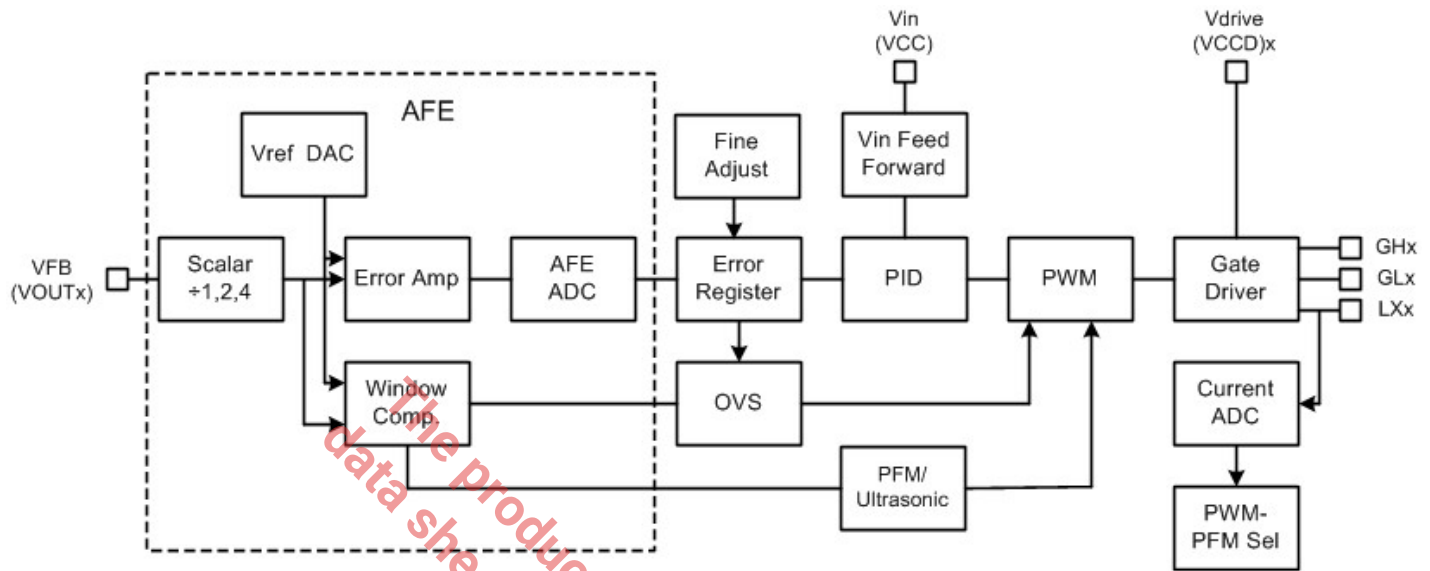


Figure 17: Regulation Loops

Figure 17 shows a simplified functional block diagram of the regulation loops for one output channel of the XR77129. There are four separate parallel control loops: Pulse Width Modulation (PWM), Pulse Frequency Modulation (PFM), Ultrasonic, and Over Sampling (OVS). Each of these loops is fed by the Analog Front End (AFE) as shown at the left of the diagram. The AFE consists of an input voltage scaler, a programmable Voltage Reference (Vref) DAC, Error Amplifier, and a window comparator. Some of the functional blocks are common and shared by each channel by means of a multiplexer.

### PWM Loop

The PWM loop operates in Voltage Control Mode (VCM) with optional Vin feed forward based on the voltage at the VCC pin. The reference voltage (Vref) for the error amp is created by a 0.15V to 1.6V DAC that has a 12.5mV resolution. In order to provide a 0.6V to 5.5V output voltage range, an input scaler is used to reduce feedback voltages for higher output voltages to bring them within the 0.15V to 1.6V control range. So for output voltages up to 1.6V (low range), the scaler has a gain of 1. For output voltages from 1.6V to 3.2V (mid range) the scalar gain is 1/2, and for voltages greater than 3.2V (high range) the gain is 1/4. This results in the low range having a reference voltage resolution of 12.5mV, the mid range having a resolution of 25mV, and the high range having a resolution of 50mV. The error amp has a gain of 4 and compares the output voltage of the scaler to Vref to create an error voltage on its output. This is converted to a digital error term by the AFE ADC and is stored in the error register. The error register has a

fine adjust function that can be used to improve the output voltage set point resolution by a factor of 5 resulting in a low range resolution of 2.5mV, a mid range resolution of 5mV and a high range resolution of 10mV. The output of the error register is then used by the Proportional Integral Derivative (PID) controller to manage the loop dynamics.

The XR77129 PID is a 17-bit five-coefficient control engine that calculates the required duty cycle under the various operating conditions and feeds it to the digital Pulse Width Modulator (PWM). Besides the normal coefficients, the PID also uses the VCC voltage to provide a feed forward function.

The XR77129 digital PWM includes a special delay timing loop that provides a timing resolution that is 16 times the master oscillator frequency (103MHz) for a timing resolution of 607ps for both the driver pulse width and dead time delays. The PWM produces the Gate High (GH) and Gate Low (GL) signals to the driver. The maximum and minimum on times and dead time delays are programmable by configuration resistors.

To provide current information, the output inductor current is measured by a differential amplifier that reads the voltage drop across the RDSON of the synchronous FET during its on time. There are two selectable ranges, a low range with a gain of 8 for a -120mV to +20mV voltage range, and a high range with a gain of 4 for -280mV to +40mV voltage range. The optimum range to use will depend on the maximum output current and the RDSON of the synchronous FET. The measured voltage drop is then converted to a digital value by the current ADC block. The



resulting current value is stored in a readable register and also used to determine when PWM to PFM transitions should occur.

### PFM Loop

The XR77129 has a PFM loop that can be enabled to improve efficiency at light loads. By reducing switching frequency and operating in the discontinuous conduction mode (DCM), both switching and conduction losses are minimized.

Figure 18 shows a functional diagram of the PFM logic.

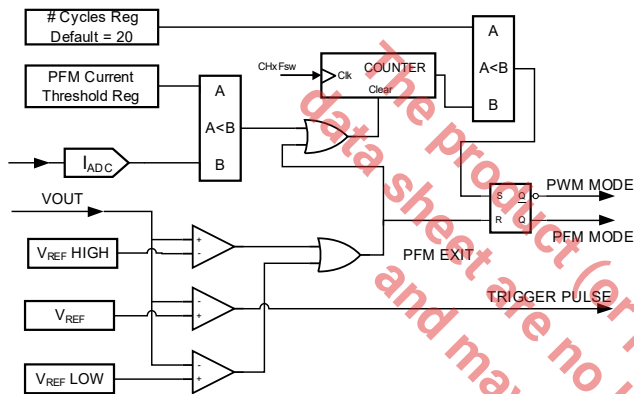


Figure 18: PFM Enter/Exit Functional Diagram

The PFM loop works in conjunction with the PWM loop and is entered when the output current falls below a programmed threshold level for a programmed number of cycles. When PFM mode is entered, the PWM loop is disabled and instead, the scaled output voltage is compared to  $V_{ref}$  with a window comparator. The window comparator has three thresholds; normal ( $V_{ref}$ ), high ( $V_{ref} + \%high$ ) and low ( $V_{ref} - \%low$ ). The  $\%high$  and  $\%low$  values are programmable and track  $V_{ref}$ .

In PFM mode, the normal comparator is used to regulate the output voltage. If the output voltage falls below the  $V_{ref}$  level, the comparator is activated and triggers the PWM to start a switching cycle. When the switching FET is turned on, the inductor current ramps up which charges up the output capacitors and increases their voltage. After the completion of the high side and low side on-times, the synchronous FET is turned off to inhibit any inductor reverse current flow. The load current then discharges the output capacitors until the output voltage falls below  $V_{ref}$  and the normal comparator is activated. This triggers the PWM to start the next switching cycle. The time from the end of the switching cycle to the next trigger is referred to as the dead zone. When PFM mode is initially entered, the switching cycle is equal to the steady-state PWM duty cycle. This will cause the inductor ripple current to be at the

same level that is in PWM mode of operation. During operation the PFM duty cycle is calculated based on the ratio of the output voltage to  $V_{CC}$ . This method ensures that the output voltage ripple is well controlled and is much lower than in other architectures which use a “burst” methodology.

If the output voltage ever goes outside the high / low windows, PFM mode is exited and the PWM loop is reactivated.

Although the PFM mode is effective at improving efficiency at light load, at very light loads the dead zone time can increase to the point where the switching frequency can enter the audio hearing range. When this happens some components, like the output inductor and ceramic capacitors, can emit audible noise. The amplitude of the noise depends mainly on the board design and on the manufacturer and construction details of the components. Proper selection of components can reduce the sound to very low levels. In general Ultrasonic Mode is not used unless required as it reduces light load efficiency.

### Ultrasonic Mode

Ultrasonic mode is an extension of PFM to ensure that the switching frequency never enters the audible range. When this mode is entered, the switching frequency is set to 30kHz and the duty cycle of the switching and synchronous FETs which are fixed in PFM mode, are decreased as required to keep the output voltage in regulation while maintaining the 30kHz switching frequency.

Under extremely light or zero load currents, the GH on time pulse width can decrease to its minimum width. When this happens, the synchronous FET on time is increased slightly to allow a small amount of reverse inductor current to flow back into  $V_{in}$  to keep the output voltage in regulation while maintaining the switching frequency above the audio range.

### Oversampling (OVS) Mode

Oversampling (OVS) mode is a feature added to the XR77129 to improve transient responses. This mode can only be enabled when the channel switching frequency is operating in 1x frequency mode. In OVS mode, the output voltage is sampled 4 times per switching cycle and is monitored by the AFE window comparator. If the voltage goes outside the set high or low limits, the OVS control electronics can immediately modify the pulse width of the GH or GL drivers to respond accordingly without having to wait for the next cycle to start. OVS has two types of response depending on whether the high limit is exceeded during an unloading transient (Over Voltage), or the low limit is exceeded during a loading transient (Under Voltage).

**Under Voltage OVS:** If there is an increasing current load step, the output voltage will drop until the regulator loop

adapts to the new conditions to return the voltage to the correct level. Depending on where in the switching cycle the load step happens there can be a delay of up to one switching cycle before the control loop can respond. With OVS enabled if output voltage drops below the lower limit of the window comparator, an immediate GH pulse will be generated and sent to the driver to increase the output inductor current toward the new load level without having to wait for the next cycle to begin. If the output voltage is still below the lower limit of the window comparator at the beginning of the next cycle, OVS will work in conjunction with the PID to insert additional GH pulses to quickly return the output voltage back within its regulation band. The result of this system is transient response capabilities on par or exceeding those of a constant on-time control loop.

**Over Voltage OVS:** When there is a step load current decrease, the output voltage will increase (bump up) as the excess inductor current that is no longer used by the load, flows into the output capacitors causing the output voltage to rise. The voltage will continue to rise until the inductor current decreases to the new load current level. With OVS enabled, if the output voltage exceeds the high limit of the window comparator, a blanking pulse is generated to truncate the GH signal. This causes inductor current to immediately begin decreasing to the new load level. The GH signal will continue to be blanked until the output voltage falls below the high limit of the window comparator. Again, since the output voltage is sampled at four times the switching frequency, overshoot will be decreased and the time required to get back into the regulation band is also decreased.

OVS can be used in conjunction with both the PWM and PFM operating modes. When it is activated it can noticeably decrease output voltage excursions when transitioning between PWM and PFM modes.

### Internal Drivers

The internal high and low gate drivers use totem pole FETs for high drive capability. They are powered by two external 5V power pins (VCCD1-2) and (VCCD3-4). VCCD1-2 powers the drivers for channels 1 and 2 while VCCD3-4 powers channels 3 and 4. The drivers can be powered by the internal 5V LDO by connecting their power pins to the LDO5 output through an RC filter to avoid conducted noise back into the analog circuitry.

To minimize power dissipation in the 5V LDO, it is recommended to power the drivers from an external 5V power source either directly or by using the V5EXT input. Good quality 1uF to 4.7uF capacitors should be connected directly between the power pins to ground to optimize driver performance and minimize noise coupling to the 5V LDO supply.

The driver outputs should be connected directly to their corresponding output switching FETs with the Lx output connected to the drain of the synchronous FET for the best current monitoring accuracy.

See ANP-32 "Practical Layout Guidelines for PowerXR Designs"

### LDOs

The XR77129 has two internal Low Drop Out (LDO) linear regulators that generate 5.0V (LDO5) and configurable voltage (LDOOUT) for both internal and external use. XR77129 can be programmed to four LDOOUT output voltage settings, 3.3V, 2.8V, 2.5V and 1.8V. Additionally, XR77129 has a 1.8V regulator that supplies power for the XR77129 internal circuits. LDO5 is the main power input to the device and is supplied by an external 6V to 40V (VCC) supply. The output of LDO5 should be bypassed by a good quality 4.7uF or larger capacitor connected between the pin and ground close to the device. The 5V output is used by the XR77129 as a standby power supply and is also used to power the LDOOUT and 1.8V linear regulators inside the chip, and can also supply power to the 5V gate drivers. The total output current that the 5V LDO can provide is 130mA. The XR77129 consumes approximately 20mA and the rest is shared between LDOOUT and the gate drive currents.

The LDOOUT output available on the LDOOUT pin is solely for customer use and is not used internally. This supply is turned on or off by the configuration registers. Again a good bypass capacitor should be used.

The AVDD pin is the 1.8V regulator output and needs to be connected externally to the DVDD pin on the device. A good quality capacitor should be connected between this pin and ground close to the package.





Table 1: Available Channel Switching Frequencies

| Base Frequency (kHz) | Available 2x Frequencies (kHz) | Available 4x Frequencies (kHz) |
|----------------------|--------------------------------|--------------------------------|
| 105.5                | 211.1                          | 422.1                          |
| 107.3                | 214.6                          | 429.2                          |
| 109.1                | 218.2                          | 436.4                          |
| 111.0                | 222.0                          | 444.0                          |
| 112.9                | 225.9                          | 451.8                          |
| 115.0                | 229.9                          | 459.8                          |
| 117.0                | 234.1                          | 468.2                          |
| 119.2                | 238.4                          | 476.9                          |
| 121.5                | 242.9                          | 485.8                          |
| 123.8                | 247.6                          | 495.2                          |
| 126.2                | 252.5                          | 504.9                          |
| 128.8                | 257.5                          | 515.0                          |
| 131.4                | 262.8                          | 525.5                          |
| 134.1                | 268.2                          | 536.5                          |
| 137.0                | 273.9                          | 547.9                          |
| 139.9                | 279.9                          | 559.8                          |
| 143.1                | 286.1                          | 572.2                          |
| 146.3                | 292.6                          | 585.2                          |
| 149.7                | 299.4                          | 598.8                          |
| 153.3                | 306.5                          | 613.1                          |
| 157.0                | 314.0                          | 628.0                          |
| 160.9                | 321.9                          | 643.8                          |
| 165.1                | 330.1                          | 660.3                          |
| 169.4                | 338.8                          | 677.6                          |
| 174.0                | 348.0                          | 695.9                          |
| 178.8                | 357.6                          | 715.3                          |
| 183.9                | 367.9                          | 735.7                          |
| 189.3                | 378.7                          | 757.4                          |
| 195.1                | 390.2                          | 780.3                          |
| 201.2                | 402.3                          | 804.7                          |
| 207.7                | 415.3                          | 830.6                          |
| 214.6                | 429.2                          | 858.3                          |
| 222.0                | 444.0                          | 887.9                          |
| 229.9                | 459.8                          | 919.6                          |

Table 1: Available Channel Switching Frequencies

| Base Frequency (kHz) | Available 2x Frequencies (kHz) | Available 4x Frequencies (kHz) |
|----------------------|--------------------------------|--------------------------------|
| 238.4                | 476.9                          | 953.7                          |
| 247.6                | 495.2                          | 990.4                          |
| 257.5                | 515.0                          | 1030.0                         |
| 268.2                | 536.5                          | 1072.9                         |
| 279.9                | 559.8                          | 1119.6                         |
| 292.6                | 585.2                          | 1170.5                         |
| 306.5                | 613.1                          | 1226.2                         |

Note: Some table entries are affected by rounding.

## Supervisory and Control

Power system design with XR77129 is accomplished using PowerArchitect™ (PA5) design tool. All figures referenced in the following sections are taken from PA5. Furthermore, the following sections reference I<sup>2</sup>C commands. For more information on these commands refer to ANP-38.

## Digital I/O

XR77129 has two General Purpose Input Output (GPIO) and three Power System Input Output (PSIO) user configurable pins.

GPIO Channel Configuration

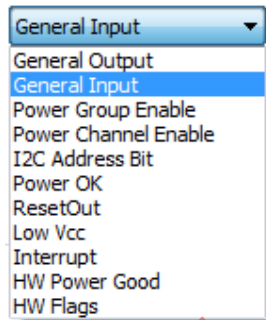
| Channel | Configuration | Triggers Interrupt, Read state with GPIO_READ_GPIO I2C Command | Invert?                  |
|---------|---------------|----------------------------------------------------------------|--------------------------|
| GPIO 0  | General Input | <input type="checkbox"/>                                       | <input type="checkbox"/> |
| GPIO 1  | General Input | <input type="checkbox"/>                                       | <input type="checkbox"/> |
| PSIO 0  | General Input | <input type="checkbox"/>                                       | <input type="checkbox"/> |
| PSIO 1  | General Input | <input type="checkbox"/>                                       | <input type="checkbox"/> |
| PSIO 2  | General Input | <input type="checkbox"/>                                       | <input type="checkbox"/> |

- GPIOs are 3.3V CMOS logic compatible and 5V tolerant.
- PSIOs configured as outputs are open drain and require external pull-up resistors. These I/Os are 3.3V and 5V CMOS logic compatible, and up to 15V capable.

The polarity of the GPIO/PSIO pins is set in PA5 or with an I<sup>2</sup>C command.

## Configuring GPIO/PSIOs

The following functions can be controlled from or forwarded to any GPIO/PSIO:



- **General Output** – set with an I<sup>2</sup>C command
- **General Input** – triggers an interrupt; state read with an I<sup>2</sup>C command
- **Power Group Enable** – controls enabling and disabling of channels placed in Group 1 and Group 2
- **Power Channel Enable** – controls enabling and disabling of a individual channel including LDOOUT
- **I<sup>2</sup>C Address Bit** – controls an I<sup>2</sup>C address bit
- **Power OK** – indicates that selected channels have reached their target levels and have not faulted. Multiple channel selection is available in which case the resulting signal is the AND logic function of all channels selected
- **ResetOut** – is delayed Power OK. Delay is programmable in 5ms increments with the range of 0 to 255ms. When no channels selected, the transition will indicate the controller has finished the booting process and is ready to communicate.
- **Low VCC** – indicates when VCC has fallen below the UVLO fault threshold and when the UVLO condition clears (VCC voltage rises above the UVLO warning level)
- **Interrupt** – the controller generated interrupt selection and clearing is done through I<sup>2</sup>C commands
- **HW Power Good** – the Power Good hardware monitoring function. It is an output voltage monitoring function that is a hardware comparison of channel output voltage against its user defined Power Good threshold limits (Power Good minimum and maximum levels). It has no hysteresis. Multiple channel selection will be combined using the AND logic function of all channels selected.

HW Power Good  Power Good: ☒ CH1 ☒ CH2 ☐ CH3 ☐ CH4

The Power Good minimum and maximum levels are expressed as percentages of the target voltage.

PGood Max (%)   
PGood Min (%)

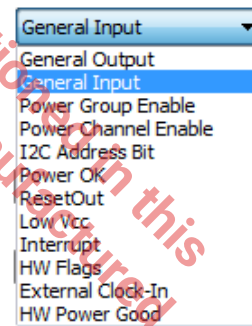
“PGood Max” is the upper window and “PGood Min” is the lower window. The minimum and maximum for each of these values can be calculated with the following equation:

$$\text{PGOOD (\%)} = \frac{N \times \text{LSB (V)} \times 10^2}{V_{\text{target (V)}}$$

Where N=1 to 63 for the PGood Max value, and N=1 to 62 for the PGood Min value. For example, with the target voltage of 1.5V and set point resolution of 2.5mV (LSB), the Power Good Min and Max values can range from 0.17% to 10.50% respectively. A user can effectively double the Power Good range by changing to the next higher output voltage range setting, but at the expense of reduced set point resolution.

Interrupt, Low VCC, Power OK and ResetOut signals can only be forwarded to a single GPIO/PSIO.

In addition, the following are functions that are unique to GPIO0 and GPIO1.

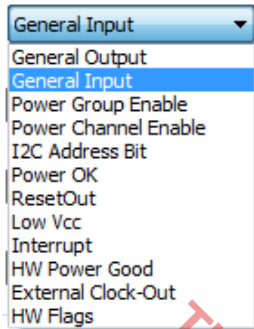


- **HW Flags** - these are hardware monitoring functions forwarded to GPIO0 only. The functions include Under-Voltage Lockout Warning, Over-Temperature Warning, Over-Voltage Fault, Over-Current Fault and Over-Current Warning for every channel. Multiple selections will be combined using the OR logic function.

GPIO 0  HW Flags   
☐ Under-Voltage Warning ☐ Over-Temp Warning  
Over-Voltage Fault: ☐ CH1 ☐ CH2 ☐ CH3 ☐ CH4  
Over-Current Fault: ☒ CH1 ☒ CH2 ☒ CH3 ☒ CH4  
Over-Current Warning: ☐ CH1 ☐ CH2 ☐ CH3 ☐ CH4

A subset of hardware flags which includes Under-Voltage Lockout Warning, Over-Temperature Warning, and Over-Voltage Fault for each channel is available on the other I/Os.

- **External Clock In** - enables the controller to lock to an external clock including one from another XR77129 applied to the GPIO0 pin. There are two ranges of clock frequencies the controller accepts, selectable by a user.



- **External Clock-out** – clock sent out through GPIO1 for synchronizing with another XR77129 (see the clock out section for more information).

## Fault Handling

There are seven different types of fault handling in XR77129:

- **Under Voltage Lockout (UVLO)** monitors voltage supplied to the VCC pin and will cause the controller to shutdown all channels if the supply drops to critical levels.
- **Over Temperature Protection (OTP)** monitors temperature of the chip and will cause the controller to shutdown all channels if temperature rises to critical levels.
- **Over Voltage Protection (OVP)** monitors regulated voltage of a channel and will cause the controller to react in a user specified way if the regulated voltage surpasses threshold level.
- **Over Current Protection (OCP)** monitors current of a channel and will cause the controller to react in a user specified way if the current level surpasses threshold level.
- **Start-up Time-out Fault** monitors whether a channel gets into regulation in a user defined time period.
- **LDO5 Over Current Protection (LDO5 OCP)** monitors current drawn from the regulator and will cause the controller to be reset if the current exceeds LDO5 limit.
- **LDOOUT Over Current Protection (LDOOUT OCP)** monitors current drawn from the regulator and will cause the controller to shut down the regulator if the current exceeds LDOOUT limit.

## UVLO

Both UVLO warning and fault levels are user programmable and set at 400mV increments in PA5.

UVLO Warning (V)  UVLO Fault (V)

When the warning level is reached the controller will generate the UVLO\_WARNING\_EVENT interrupt. In addition, the host can be informed about the event through HW Flags (see the Digital I/O section).

When an UVLO fault condition occurs, the XR77129 outputs are shut down and the UVLO\_FAULT\_ACTIVE\_EVENT interrupt is generated. In addition, the host can be informed by forwarding the Low VCC signal to any GPIO/PSIO (see the Digital I/O section). This signal transitions when the UVLO fault occurs. When coming out of the fault, rising VCC crossing the UVLO fault level will trigger the UVLO\_FAULT\_INACTIVE\_EVENT interrupt.

Once UVLO condition clears (VCC voltage rises to or above the user defined UVLO warning level), the Low VCC signal will transition and the controller will be reset.

## OTP

User defined OTP warning, fault and restart levels are set at 5°C increments in PA5.

OTP Warning (°C)  OTP Fault (°C)   
Enable Temp. Monitoring in Standby Mode ☐ OTP Restart Threshold (°C)

When the warning level is reached the controller will generate the TEMP\_WARNING\_EVENT interrupt. In addition, the host can be informed about the event through HW Flags (see the Digital I/O section).

When an OTP fault condition occurs, the XR77129 outputs are shutdown and the TEMP\_OVER\_EVENT interrupt is generated.

Once temperature reaches a user defined OTP Restart Threshold level, the TEMP\_UNDER\_EVENT interrupt will be generated and the controller will reset.

## OVP

A user defined OVP fault level is set in PA5 and is expressed in percentages of a regulated target voltage.

OVP (%)

Resolution is the same as for the target voltage (expressed in percentages). The OVP minimum and maximum values are calculated by the following equation where the range for N is 1 to 63:

$$\text{OVP (\%)} = \frac{N \times \text{LSB (V)} \times 10^2}{V_{\text{target}} \text{ (V)}}$$

When the OVP level is reached and the fault is generated, the host will be notified by the SUPPLY\_FAULT\_EVENT interrupt generated by the controller. The host then can use an I<sup>2</sup>C command to check which channel is at fault.

In addition, OVP fault can be monitored through any I/O.

A user can choose one of three options in response to an OVP event: to shutdown the faulting channel, to shut down faulting channel and to perform auto-restart of the channel, or to restart the chip.

Choosing the “Restart Chip” option during development is not recommended as it makes debug efforts difficult.



For the case of Shutdown and Auto-restart Channel, the user has an option to specify startup timeout (the time in which the fault is validated) and hiccup timeout (the period after which the controller will try to restart the channel) periods in 1 ms increments with a maximum value of 255 ms.

| Startup Timeout (ms) | Hiccup Timeout (ms) |
|----------------------|---------------------|
| 100                  | 100                 |
| 100                  | 100                 |
| 100                  | 100                 |
| 100                  | 100                 |

Note: The Channel Fault Action response is the same for an OVP or OCP event.

## OCP

A user defined OCP fault level is set with 10mA increments in PA5. PA5 uses calculations to give the user the approximate DC output current entered in the current limit field. However, the actual current limit trip value programmed into the part is limited to 280mV as defined in the electrical characteristics. The maximum value the user

can program is limited by RDSON of the synchronous Power FET and current monitoring ADC range. For example, using a synchronous FET with RDSON of 30mΩ and the wider ADC range, the maximum current limit programmed would be:

$$\text{OCP Max (A)} = \frac{280\text{mV}}{30\text{m}\Omega} = 9.33\text{A}$$

XR77129 samples current approximately 30ns before the synchronous FET turns off, so the actual measured DC output current in this example would be 9.33A plus approximately half the inductor ripple.

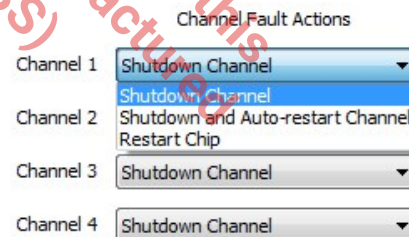
The output current reported by the XR77129 is processed through a seven sample median filter in order to reduce noise.

When the OCP level is reached and the fault is generated, the host will be notified by the SUPPLY\_FAULT\_EVENT interrupt generated by the controller. The host then can use an I<sup>2</sup>C command to check which channel is at fault.

In addition, OCP fault can be monitored through HW Flags on GPIO0. The host can also monitor OCP warning flag through HW Flags on GPIO0. The OCP warning level is calculated by PA5 as 85% of the OCP fault level.

A user can choose one of three options in response to an OCP event: shut down the faulting channel, shut down the faulting channel and perform auto-restart of the channel, or restart the chip.

Choosing the “Restart Chip” option during development is not recommended as it makes debug efforts difficult.



For the case of Shutdown and Auto-restart Channel, the user has an option to specify startup timeout (the time in which the fault is validated) and hiccup timeout (the period after which the controller will try to restart the channel) periods in 1 ms increments with a maximum value of 255 ms.

Note: The Channel Fault Action response is the same for an OCP or OVP event.



## Start-up Time-out Fault

A channel will be at Startup Timeout Fault if it does not come up in the time period specified in the “Startup Time-out” box.

When the fault is generated, the host will be notified by the SUPPLY\_FAULT\_EVENT interrupt generated by the controller. The host then can use an I<sup>2</sup>C command to check which channel is at fault.

## LDO5 OCP

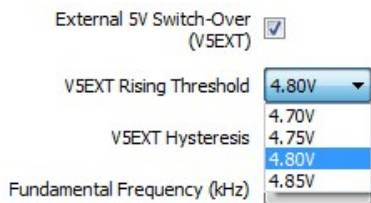
When current is drawn from LDO5 that exceeds LDO5 current limit, the controller gets reset.

## LDOOUT OCP

When current drawn from LDOOUT exceeds LDOOUT current limit the regulator gets shut down, a fault is generated, and the host will be notified by the SUPPLY\_FAULT\_EVENT interrupt generated by the controller. The host then can through an I<sup>2</sup>C command check which channel/regulator is at fault. Once the fault condition is removed, the host needs to turn the regulator on again.

## V5EXT Switchover and Control

The XR77129 has a function called V5EXT that allows an external 5V power supply to be used to supply its internal 5V (LD05) housekeeping voltage instead of using its internal 5V LDO. This function can notably reduce the controller’s power dissipation and improve overall system operating efficiency (particularly in the PFM mode).



When enabled in PA5, LD05 will automatically switch over to the external supply and disable the internal LDO when the V5EXT voltage reaches a programmable threshold voltage. The switchover thresholds are programmable in 50mV steps with a total range of 200mV. Hysteresis to switch the external 5 Volt supply in and out is 150mV. LDO5 automatically turns off when the external voltage is switched in. This is referred to as Forward Transfer.

There are two voltage sequencing requirements to use the V5EXT function:

1. Power On - The chip’s VCC voltage has to be applied prior to the V5EXT voltage. If the V5EXT voltage however is present before VCC is applied, adding a simple logic FET to the V5EXT input will meet this requirement. This is

described in detail in the “Operating from a System 5V” section.

2. Power Off - Once the forward transfer is complete, the controller’s internal circuits are then operating on the external 5V supply, so the V5EXT voltage has to remain in regulation, above the switchover threshold, as long as any output is operating. Once all outputs are disabled the V5EXT supply can be turn off (Off Last). This will ensure that no false faults are indicated during shutdown.

When using V5EXT, an additional good quality 22uF capacitor needs to be placed from the LDO5 pin to ground to filter out any potential noise from getting into the internal analog blocks.

If the V5EXT function is not used, the V5EXT pin should be either grounded or left floating, in conjunction with making sure the function gets disabled through PA5.

## Operating from a Generated 5V Output

It is recommended when using the 5VEXT function, that the 5V rail be generated by one of the XR77129 outputs and routed back to the V5EXT pin. This meets the Power On sequence requirement. Power down sequencing requires that the V5EXT supply remains on until the all outputs are powered down. Therefore, the 5V rail should be defined in PA5 as the last to be shut down. If the 5V output has no requirement for being actively shut down, then set the “Active Shutdown Threshold” to 5V.

## Operating from a System 5V

The system 5V rail must be regulated to a value of 5V, -5%/+10% and the V5EXT switchover threshold must be set to 4.8V in PA5.

VCC must be applied to the chip before connecting the System 5V to the V5EXT pin. If the system 5V rail is an always on rail, a simple way to meet the Power On sequencing requirement is to add a logic NFET, with the Source connected to the V5EXT pin, the Gate to VCC pin and the Drain to the system 5V supply. For proper operation the VCC input voltage must be greater than 5V plus the NFET threshold voltage. In this configuration, the ENABLE pin of the XR77129 should be left floating. Again the V5EXT supply has to remain on until all the output have been turned off.

## Fault Management

Fault management settings, when V5EXT is XR77129 generated require, that the other three rails follow the 5V rail if it faults. There are three fault actions the 5V rail may take: “Shutdown Channel,” “Shutdown and Auto-restart Channel,” and “Restart Chip.” If “Shutdown Channel” is selected, outside interaction is required to restart the 5V and the other three rails. This may be through I<sup>2</sup>C, I/Os or



VCC power cycling. If “Shutdown and Auto-restart Channel” is selected, to restart the other channels, an I/O should be assigned as HW Power Good or Power OK for the 5V output and connected to a second I/O configured to “Enable” for the other three outputs. Lastly, “Restart Chip” is the simplest to use for auto recovery.

Fault management settings when using the system 5V for V5EXT require that all outputs have OVP set to 5% with fault action set to “Restart Chip”.

## External Clock Synchronization

XR77129 can be run off an external clock available in the system or another XR77129. The external clock must be in the ranges of 10MHz to 15.5MHz or 20MHz to 31MHz. Locking to the external clock is done through an internal Phase Lock Loop (PLL) which requires an external loop capacitor of 2.2nF to be connected between the CPLL pin and AGND.

In applications where this functionality is not desired, the CPLL capacitor is not necessary and can be omitted, and the pin shall be left floating. In addition, the user needs to make sure the function gets disabled through register settings.

The external clock must be routed to GPIO0. The GPIO0 setting must reflect the range of the external clock applied to it: Sys\_Clock/8 corresponds to the range of 10MHz to 15.5MHz while Sys\_Clock/4 setting corresponds to the range of 20MHz to 31MHz.

The functionality is enabled in PA5 by selecting External Clock-in function under GPIO0.

GPIO 0  External Clock-In ☒ Sys\_Clock/4 ☐ Sys\_Clock/8

When the controller switches over to the external clock, the PLL\_LOCK\_IN interrupt is generated to inform the host. To the contrary, when the controller switches back to the internal clock source, the PLL\_LOCK\_OUT interrupt gets generated.

## Clock Out

XR77129 can supply clock out to be used by another XR77129 controller. The clock is routed out through GPIO1 and can be set to the system clock divided by 8 (Sys\_Clock/8) or the system clock divided by 4 (Sys\_Clock/4) frequencies.

The functionality is enabled in PA5 by selecting External Clock-Out function under GPIO1.

GPIO 1  External Clock-Out ☒ Sys\_Clock/4 ☐ Sys\_Clock/8

## Channel Control

| Channel   | Enable | InReg | Fault | Status | Vout    | Iout   |
|-----------|--------|-------|-------|--------|---------|--------|
| Channel 1 | On     | Off   | Green | Green  | 3.240 V | 0.17 A |
| Channel 2 | On     | Off   | Green | Green  | 1.800 V | 0.26 A |
| Channel 3 | On     | Off   | Green | Green  | 1.485 V | 1.08 A |
| Channel 4 | On     | Off   | Green | Green  | 0.990 V | 1.39 A |
| LDO 3.3   | On     | Off   | Green | Green  |         |        |

Channel 1 Settings: Set Voltage 1.3000

Group 0: On Off Group 1: On Off Group 2: On Off

Channels including LDOOUT can be controlled independently by any GPIO / PSIO or I<sup>2</sup>C command. Channels will start-up or shut-down following transitions of signals applied to GPIO/PSIOs set to control the channels. The control can always be overridden with an I<sup>2</sup>C command.

Regardless of whether the channels are controlled independently or are in a group, the ramp rates will be followed as specified (see the Power Sequencing section).

Regulated voltages and voltage drops across the synchronous FET on each switching channel can be read back using I<sup>2</sup>C commands. The regulated voltage read back resolution is 15mV, 30mV and 60mV per LSB depending on the target voltage range. The voltage drop across the synchronous FET read back resolution is 1.25mV and 2.5mV per LSB depending on the range.

Through an I<sup>2</sup>C command the host can check the status of the channels; whether they are in regulation or at fault.

Regulated voltages can be dynamically changed on switching channels using I<sup>2</sup>C commands with resolution of 2.5mV, 5mV and 10mV depending on the target voltage range (in PWM mode only).

For more information on I<sup>2</sup>C commands refer to ANP-38, or contact Exar or your local Exar representative.

## Power Sequencing

All four channels and LDOOUT can be grouped together and will start-up and shut-down in a user defined sequence.

Selecting none means channel(s) will not be assigned to any group and therefore, will be controlled independently.

## Group Selection

Power Enable Groups

|           | None                  | Group 0<br>(@ Chip Enable)       | Group 1               | Group 2               |
|-----------|-----------------------|----------------------------------|-----------------------|-----------------------|
| Channel 1 | <input type="radio"/> | <input checked="" type="radio"/> | <input type="radio"/> | <input type="radio"/> |
| Channel 2 | <input type="radio"/> | <input checked="" type="radio"/> | <input type="radio"/> | <input type="radio"/> |
| Channel 3 | <input type="radio"/> | <input checked="" type="radio"/> | <input type="radio"/> | <input type="radio"/> |
| Channel 4 | <input type="radio"/> | <input checked="" type="radio"/> | <input type="radio"/> | <input type="radio"/> |
| LDO 3.3V  | <input type="radio"/> | <input checked="" type="radio"/> | <input type="radio"/> | <input type="radio"/> |

There are three groups:

- **Group 0** – is controlled by the chip ENABLE or an I<sup>2</sup>C command. Channels assigned to this group will come up with the ENABLE signal being high (plus additional delay needed to load a configuration from Flash memory to run-time registers), and will go down with the ENABLE signal being low. The control can always be overridden with an I<sup>2</sup>C command.
- **Group 1** – can be controlled by any GPIO/PSIO or an I<sup>2</sup>C command. Channels assigned to this group will start-up or shut-down following transitions of a signal applied to the GPIO/PSIO set to control the group. The control can always be overridden with an I<sup>2</sup>C command.
- **Group 2** – can be controlled by any GPIO/PSIO or an I<sup>2</sup>C command. Channels assigned to this group will start-up or shut-down following transitions of a signal applied to the GPIO/PSIO set to control the group. The control can always be overridden with an I<sup>2</sup>C command.

### Start-up

| Startup   |                  |         |             |
|-----------|------------------|---------|-------------|
|           | Ramp Rate (V/ms) | Group 0 |             |
| Channel 1 | 0.499            | Order   | Wait PGOOD? |
| Channel 2 | 0.988            | Order   | Delay (ms)  |
| Channel 3 | 1.029            | Order   | Delay (ms)  |
| Channel 4 | 1.029            | Order   | Delay (ms)  |
| LDO 3.3V  |                  | Order   | Delay (ms)  |

For each channel within a group a user can specify the following start-up characteristics:

- **Ramp Rate** – expressed in Volts per milliseconds. It does not apply to LDOOUT.
- **Order** – position of a channel to come-up within the group
- **Wait PGOOD?** – selecting this option for a channel means the next channel in the order will not start ramping-up until this channel reaches the target level and its Power Good flag is asserted.
- **Delay** – an additional time delay a user can specify to postpone a channel start-up with respect to the previous channel in the order. The delay is expressed in milliseconds with a range of 0ms to 255ms.

### Shut-down

| Shutdown  |       |         |                  |
|-----------|-------|---------|------------------|
|           |       | Group 0 |                  |
| Channel 1 | 0.499 | Order   | Wait StopThresh? |
| Channel 2 | 0.988 | Order   | Delay (ms)       |
| Channel 3 | 1.029 | Order   | Delay (ms)       |
| Channel 4 | 1.029 | Order   | Delay (ms)       |
| LDO 3.3V  |       | Order   | Delay (ms)       |

For each channel within a group a user can specify the following shut-down characteristics:

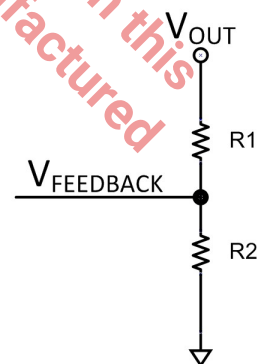
- **Ramp Rate** – expressed in Volts per milliseconds. It does not apply to LDOOUT.
- **Order** – position of a channel to come-down within the group
- **Wait Stop Thresh?** – selecting this option for a channel means the next channel in the order will not start ramping down until this channel reaches the Stop Threshold level.
- **Delay** – additional time delay a user can specify to postpone a channel shut-down with respect to the previous channel in the order. The delay is expressed in milliseconds with a range of 0ms to 255ms.

### Monitoring VCC and Temperature

Through I<sup>2</sup>C commands, the host can read back voltage applied to the VCC pin and the die temperature respectively. The VCC read back resolution is 400mV per LSB; the die temperature read back resolution is 5C° per LSB. For more on I<sup>2</sup>C commands refer to ANP-38.

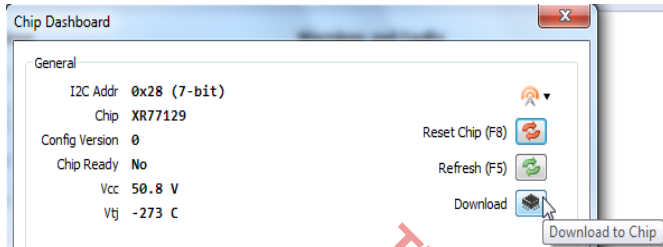
### Regulating higher than 5.5V

To set the output voltage higher than 5.5V, the user needs to add an external voltage divider. The resistors used in the voltage divider should be below 20kΩ. In practice, the PA5 design tool handles all the details and the user only has to enter the desired output voltage. The PA5 tool will recommend resistor divider values which can be modified by the user.



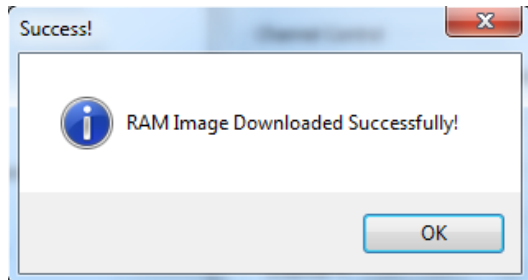
## Downloading Configuration to XR77129

A key benefit of MaxLinear's programmable power technology is the ability to easily update the design and chip configuration during development. The best way to do this is to program the RAM memory rather than programming the FLASH NVM.



PA5 provides a RAM download function accessible through the Dashboard or through the "Tools" menu.

RAM programming requires that there is no valid configuration in the FLASH NVM. A valid configuration is loaded in the chip if in the Dashboard window, the "Reset Chip" (F8) button is clicked and after a short delay the "Chip Ready" indicates "Yes". When a new configuration is loaded into RAM with a chip that already contains a valid configuration in FLASH NVM, the first step will be to invalidate the FLASH configuration. The device will be reset to clear the prior RAM content and then the new run time configuration gets loaded. PA5 will indicate that it successfully downloaded the configuration to run time registers after which the "Chip Ready" indicator will be asserted by PA5 acting as a host.



If the configuration changes I<sup>2</sup>C address, the device will respond to the new address at this point.

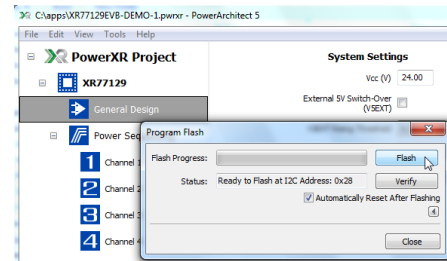
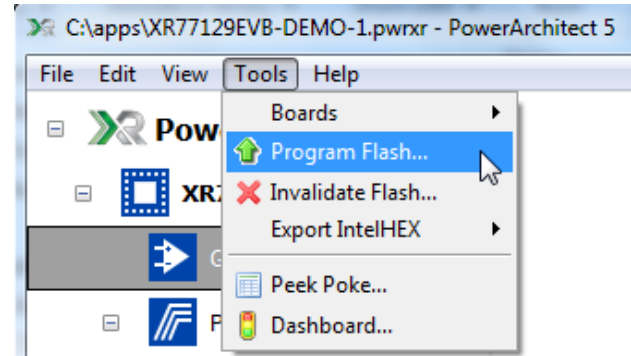
For users that wish to create their own downloading procedure, they can refer to ANP-39.

## Programming XR77129

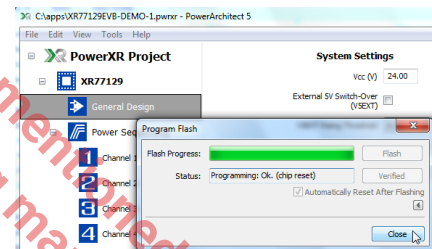
Once the design has been tested and verified its configuration can permanently be saved into FLASH NVM.

XR77129 is a FLASH based device which means its configuration can be programmed into FLASH NVM and re-programmed a number of times.

Programming of FLASH NVM is done through PA5.



By clicking on the Flash button, user will start programming sequence of the design configuration into the Flash NVM. After the programming sequence completes, the chip will reset (if the Automatically Reset After Flashing box is checked), and boot the design configuration from the Flash.



For users that wish to create their own programming procedure so they can re-program Flash in-circuit using their system software, they should contact Exar for a list of I<sup>2</sup>C Flash Commands needed or refer to ANP-38.

## Enabling XR77129

XR77129 has an internal pull-up ensuring it gets enabled as soon as internal voltage supplies have ramped up and are in regulation.

Driving the Enable pin low externally will keep the controller in the shut-down mode. A simple open drain pull down is the recommended way to shut XR77129 down.

If the Enable pin is driven high externally to control XR77129 coming out of the shut-down mode, care must be taken in such a scenario to ensure the Enable pin is driven high after VCC gets supplied to the controller.

A diode in series with a resistor between the LDO5 and ENABLE pins may offer a way to more quickly pull down the LDO5 output when the ENABLE pin is pulled low.

## Application Information

### Thermal Design

As a four channel controller with internal MOSFET drivers and 5V gate drive supply all in one 7x7mm 44pin TQFN package, there is the potential for the power dissipation to exceed the package thermal limitations. The XR77129 has an internal LDO which supplies 5V to the internal circuitry and MOSFET drivers during startup. It is generally expected that either one of the switching regulator outputs is 5V or another 5V rail is available in the system and connected to the V5EXT pin. If there is no 5V available in the system, then the power loss will increase significantly and proper thermal design becomes critical. For lower power levels using properly sized MOSFETs, the use of the internal 5V regulator as a gate drive supply may be appropriate.

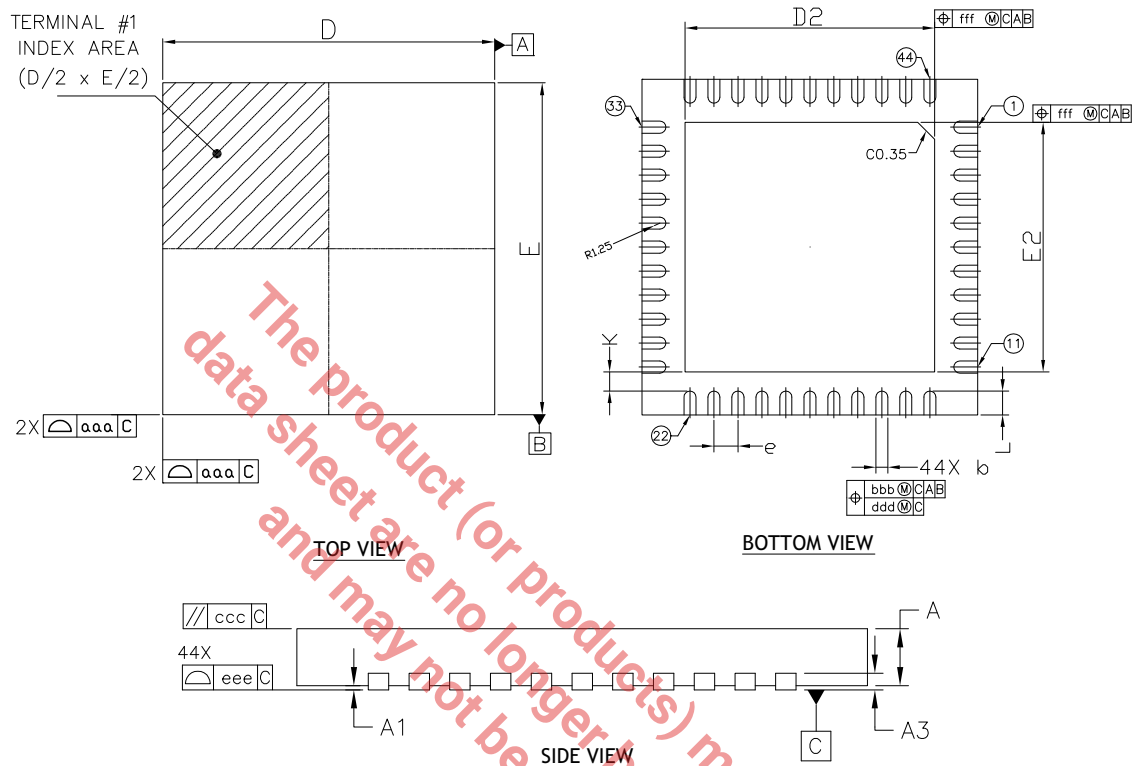
### Layout Guidelines

Refer to application note ANP-32 "Practical Layout Guidelines for PowerXR Designs".

This product (or products) mentioned in this data sheet are no longer being manufactured and may not be ordered (OBS)

## Mechanical Dimensions

### 44-Pin TQFN



| DIM SYMBOL | MIN  | NOM      | MAX  |
|------------|------|----------|------|
| A          | 0.70 | 0.75     | 0.80 |
| A1         | 0.00 | 0.02     | 0.05 |
| A3         |      | 0.20Ref  |      |
| b          | 0.18 | 0.25     | 0.30 |
| D          |      | 7.00 BSC |      |
| E          |      | 7.00 BSC |      |
| e          |      | 0.50 BSC |      |
| D2         | 5.00 | 5.15     | 5.30 |
| E2         | 5.00 | 5.15     | 5.30 |
| L          | 0.40 | 0.50     | 0.60 |
| K          | 0.20 | —        | —    |
| aaa        |      | 0.15     |      |
| bbb        |      | 0.10     |      |
| ccc        |      | 0.10     |      |
| ddd        |      | 0.05     |      |
| eee        |      | 0.08     |      |
| fff        |      | 0.10     |      |
| N          |      | 44       |      |

#### TERMINAL DETAILS

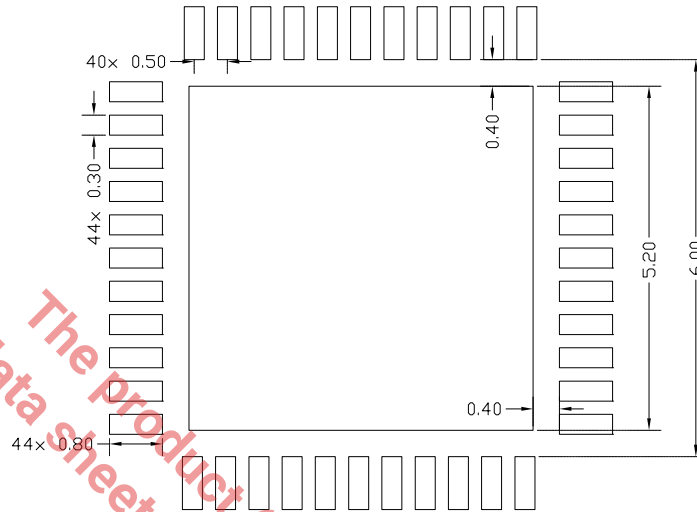
NOTE : ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES ARE IN DEGREES.

Drawing No.: POD-00000049

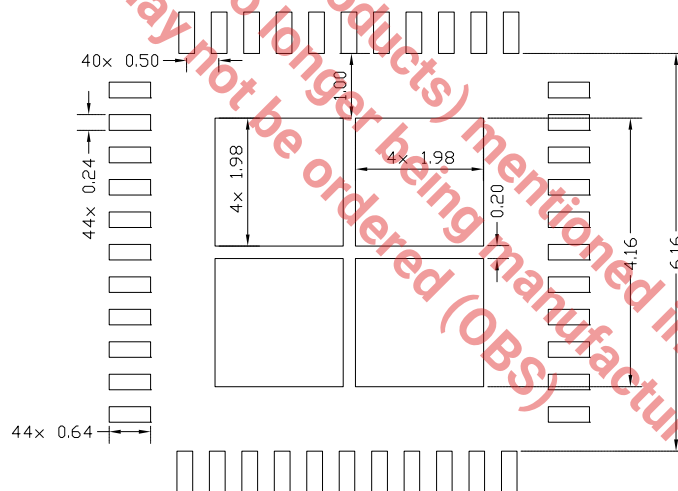
Revision: B

## Recommended Land Pattern and Stencil

44-Pin TQFN



TYPICAL RECOMMENDED LAND PATTERN



TYPICAL RECOMMENDED STENCIL

NOTE : ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES ARE IN DEGREES.

Drawing No.: POD-00000049

Revision: B



## Ordering Information<sup>(1)</sup>

| Part Number            | Operating Temperature Range                                                                                      | Lead-Free          | Package     | Packaging Method | Default I <sup>2</sup> C Address |
|------------------------|------------------------------------------------------------------------------------------------------------------|--------------------|-------------|------------------|----------------------------------|
| XR77129ELB-F           | -40°C to +125°C                                                                                                  | Yes <sup>(2)</sup> | 44-pin TQFN | Tray             | 0x28 (7-bit)                     |
| XR77129EVB-DEMO-1      | XR77129 evaluation board                                                                                         |                    |             |                  |                                  |
| XR77129EVB-DEMO-1-KITA | The demonstration kit includes an XR77129 evaluation board with PowerArchitect software and Configuration Module |                    |             |                  |                                  |
| XR77XXEVB-XCM-V62      | Configuration Module                                                                                             |                    |             |                  |                                  |

### NOTES:

1. Refer to [www.exar.com/XR77129](http://www.exar.com/XR77129) for most-up-to-date Ordering Information.
2. Visit [www.exar.com](http://www.exar.com) for additional information on Environmental Rating.

## Revision History

| Revision | Date          | Description                                                                                            |
|----------|---------------|--------------------------------------------------------------------------------------------------------|
| 1A       | December 2014 | Initial Release                                                                                        |
| 1B       | May 2018      | Update to MaxLinear logo. Update format and Ordering Information.                                      |
| 1C       | February 2019 | Update PGOOD and OVP equation formats. Updated Ordering Information. Simplify PA5.2 references to PA5. |



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